



SITE TECHNICAL DOCUMENTATION

myC-1

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CHAPTER 1 - FOREWORD

This document is common to all phones in the SAGEM. It is composed of independent sheets:

- Symptom sheets = Symp Sheet XX
- Test and check sheet = Test Sheet XX
- Maintenance procedure sheet = Proc Sheet X XX

The applicability of a procedure is indicated in the independent sheets title block:

- All types = GSM 850/900, GSM 1800/1900 and dual band.

These sheets are updated from time to time in Technical Information Bulletins (TIB).

The information contained in this document is non-contractual, since phone characteristics can change.

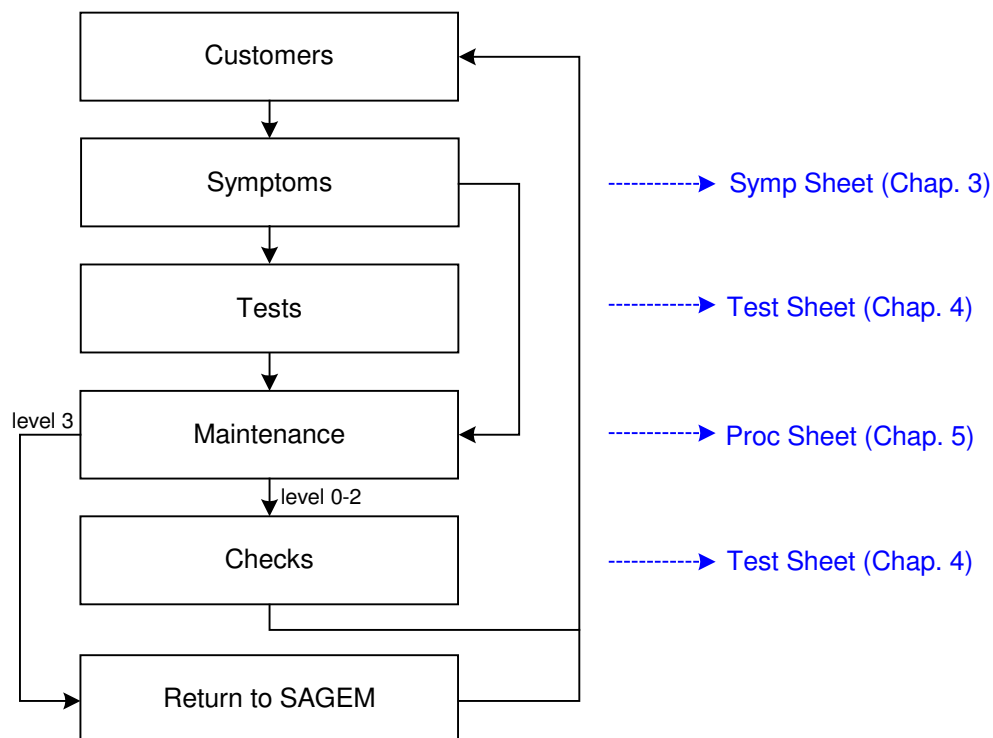
Phones are managed based on *SAGEM* handset codes; any order for spare parts must refer to these codes (typical code 25 xxx xxx-x).

1.1 HOW TO USE THE SITE TECHNICAL DOCUMENTATION

This is a modular document. Each sheet is unique and independent. In some cases several sheets may have to be used in order to determine the complete procedure to be applied.

A troubleshooting chapter (chapter 3) is provided and is sorted according to the type of reported fault, to determine the maintenance procedure to be carried out.

These sheets describe the procedure to be followed. They refer to test sheets or removal and replacement maintenance sheets. Maintenance, executed by the repair center, terminates either by returning the product to the customer, or by dispatching it to level 3 maintenance (return to factory).



All sheets include illustrations to make it easier to read the procedure.

- **Chapter 1 : Foreword**, describes general data about this document.
- **Chapter 2 : Description - Operation**, describes general data and options available in the myC-1.
- **Chapter 3 : Symptoms**, contains troubleshooting procedures to be carried out on equipment.
- **Chapter 4 : Tests and checks**, contains tests and check procedures to be performed on the equipment.
- **Chapter 5 : Maintenance procedures**, contains level 0 to 2 maintenance procedures to be carried out on the equipment, and the procedure to return to SAGEM level 3.
- **Chapter 6 : Technical Information Bulletins**, contains the various modifications made to this documentation.
- **Chapter 7 : Illustrated Parts Catalogue**, contains the various reference for spare parts.
- **Appendix 1: Composition table**, contains the various SAGEM references codes for equipment described in this document.

1.2 ABBREVIATIONS

AAC	Advanced Audio Coder
ADPCM	Adaptive Differential Pulse Codec Modulation
ALS	Alternative Line Services
AOC	Advice Of Charge
CCD	Charged Coupled Device
CLI	Calling Line Identification
CLIP	Calling Line Identification Presentation
CSTN	Colored Super Twisted Nematic
DCS	Digital Cellular System
EFR	Enhanced Full Rate
EMS	Enhanced Message Service
FDN	Fixed Dial Number
GPRS	General Packet Radio Service
GSM	Global System for Mobile
IMEI	International Mobile Equipment Identity
ISO	International Standard Organisation
LCD	liquid Crystal Display
LU	Livret d'Utilisation (User's guide)
MMS	Multimedia Message Service
PCS	Personal Communication Service
PIN	Personal Identity Number
PUK	PIN Unlocking Key
RF	Radio Frequency
SAR	Specific Absorption Rate

SIM	Subscriber Identify Module
SMS	Short Message Service
SMS CB	Short Service Message Cell Broadcast
SMT	Sagem Mobiles Tools
TFT	Thin Film Transistors
USSD	Unstructured Supplementary Service Data
VGA	Video Graphics Array
WiFi	Wireless Fidelity
WAP	Wireless Application Protocol
WSP	Wireless Session Protocol

1.3 COMMENTS SHEET

Broad experience is very beneficial in several respects. Please let us know your comments so that we can improve the contents and presentation of this document.

Your suggestions will be read carefully by :

- the design laboratory,
- production,
- the purchasing department,
- the after sales service,
- all users of this document.

All your suggestions are valuable, they will help us to better satisfy you.

Please photocopy and fill in the sheet 1-4.

Document title: **Site Technical Document for myC-1**

Reference : **SCT U38 SSC DTS 0016**

Date :

Please fill in the following table :

	Excellent	Good	Fairly good	Passable
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- ☐ Improve the overall view
- ☐ Improve the table of contents
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Would you like to discuss the problems mentioned in this questionnaire? If so, state :

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THANK YOU FOR PARTICIPATING IN THIS ENQUIRY. YOUR COMMENTS WILL HELP US CONTINUE TO IMPROVE THE QUALITY OF OUR DOCUMENTATION AND THUS BETTER SATISFY YOUR NEEDS.

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CHAPTER 2 - DESCRIPTION - OPERATION

2.1 REMINDERS ABOUT THE GENERAL NETWORKS CHARACTERISTICS

Table 1 below gives the characteristics of the radio interface for the GSM 850 / 900, GSM 1800 and GSM 1900 systems :

	GSM 850	GSM 900	GSM 1800	PCS 1900
Frequency Band (MHz)	824 - 849 869 - 894	890 - 915 925 - 960	1710 - 1785 1805 - 1880	1850 - 1910 1930 - 1990
Number of time intervals per TDMA frame	8			
Width 2 x W simplex (MHz)	2 x 25	2 x 25	2 x 75	2 x 60
Duplex spacing (MHz)	45	45	95	80
Modulation speed (kbit/s)	271			
Speech throughput (kbit/s)	13 (5,6)			
Maximum data throughput (kbit/s)	12			
Multiple access	Frequency and temporal multiplexing / frequency duplexing			
Cell radius (km)		0,3 to 30	0,1 to 4	0,1 to 4
SAGEM terminal power (W)	2	2	1	1
Table 1 : Radio Interface				

Table 2 shows powers as a function of the network :

	GSM 850 / 900		GSM 1800		PCS 1900	
Class number	Maximum nominal power (W)	Allowable interval (W)	Maximum nominal power (W)	Allowable interval (W)	Maximum nominal power (W)	Allowable interval (W)
1	-	-	1	[0,63 ; 1,6]	1	
2	8	[5,0 ; 12,7]	0,25	[0,16 ; 0,4]	0,25	
3	5	[3,2 ; 7,9]	4	[2,5 ; 6,3]	2	
4	2	[1,3 ; 3,2]				
5	0,8	[0,5 ; 1,3]				
Table 2: Terminals power class						



Table 3 shows power classes :

	Class 1	Class 2	Class 3	Class 4	Class 5
SM 850 / 900	43 dBm	39 dBm	37 dBm	33 dBm	29 dBm
GSM 1800	30 dBm	24 dBm	36 dBm	-	-
GSM 1900	30 dBm	24 dBm	33 dBm	-	-
Table 3: RF power classes					

2.2 REMINDERS ABOUT THE CHARACTERISTICS AND OPTIONS OF myC-1

Remark: This information is given for guidance, and is in no way contractual characteristics vary according to customers and countries.

GENERAL CHARACTERISTICS		
Size		
Dimension (LxWxH, mm)	84x44x19	
Weight (g)	80	
Volume (cm3)	70	
Power Management		
Battery type	Li-ion 550mAh	
Charging time	3h	
Talk time (TW.09)	2h30	
Standby time (TW.09)	200h	
Display and User Interface		
Screen type	STN	
Colours	Black and White	
Number of lines	Up to 7 lines + 1 icons column	
Screen size LxH (mm)	28,66 x 22,65	
Screen resolution (pixels)	96x64 + icons column (112x 64)	
Backlight	Yes, green	
Soft keys / navigation	3 direct access key, 2 directions keys	
Sub LCD (clam design)	No, main LCD visible trough window	
Customisation		
Handset colours	Silver	
Interchangeable covers	No	
Radio		
GSM Band	900-1800 MHz	
Automatic switching between bands	Yes	
Voice codecs	EFR,HR,FR	
Operating System		
CONNECTIVITY		
Radio		
GPRS	No	
UMTS	No	
Internet		
Browser	No	
Push	No	
Built-in data / fax Modem	No	
Data Transfer		
Serial	No	
IrDA (Obex or other standard)	No	
Bluetooth	No	
USB	No	
WiFi (802.11b,a)	No	
PC/MAC directory synchronisation	No	
MULTIMEDIA		
Messaging		
SMS	MO/MT/CB	
Long SMS	Yes	
EMS	No	
MMS	No	





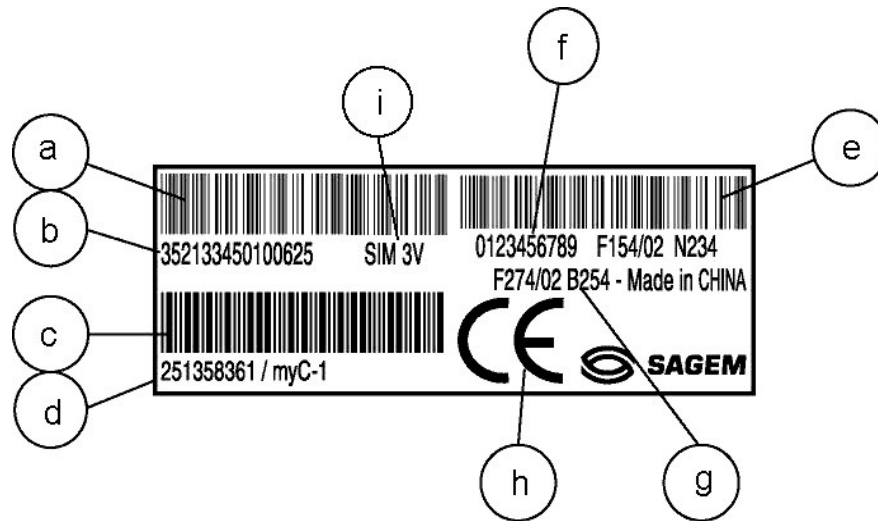
Instant messaging (IMPS) - Chat	No
MULTIMEDIA (cont'd)	
Notification	Yes
Predictive text input	T9
Video & Images	
Camera	No
Image features	No
Video Player	No
Image Format	n/a
Audio	
Audio Recorder	No
Audio player	Yes for ringtones
Polyphonic ringtones	8 tones
Audio formats	Proprietary
Entertainment	
Wallpaper	No
Screensaver	Yes
Clock display	Yes, analog or digital
Icons	No
Embedded Games	Yes, 1 : Taquin
Java	No
OTA Downloads	
Protocol supported	Not applicable
Wallpaper / screensaver	Not applicable
Animation	Not applicable
Menu icon	Not applicable
Games	Not applicable
Ringtone	Yes, by SMS only
Music	Not applicable
Java application	Not applicable
CALL MANAGEMENT	
Voice features	
Mute mode	No
Integrated handsfree mode	Yes
Address book features	
Call group	Yes
Personal information management (V-card)	No
Ringtone / Icon customisation	No
Advanced Features	
Conference call	No
Call list (dialled, received and missed)	Yes
Caller ID	Yes
Anonymous mode	Yes
Call wait / call hold / call transfer	No
Call forwarding	No
Sim toolkit	Yes
Vibrate mode	Yes
Speed dialling	voice mail only by long press on '1'
Automatic redial	Yes
Any key answer	Yes
Automatic hang up	Yes
SPECIAL FEATURES	
Keyboard Features	
Scroll key	Yes, 2
Direct access key (ADN, SMS, WAP, i-mode)	3 programmable keys
Keypad lock	Yes
Silent key	Yes, by long press on *

International access key	Yes, by long press on 0
SPECIAL FEATURES (cont'd)	
Personal Management Features	
Calculator	Yes
Alarm Clock	Yes
Stop watch	Yes
Organizer	No
To Do	No
Voice recorder	No
Currency converter	Yes
Languages	Up to 4 languages
Compatible Accessories	
Data cord	No
Universal charger	Yes
Hands free kit	No
MEMORY	
Internal phone book (positions)	up to 100
Messaging memory SMS/EMS/MMS/Email (positions)	up to 10
Redial list (positions)	up to 20
Additional multimedia memory	No
Embedded memory (Max size for total user objects)	n/a

2.3 IDENTIFICATION

All phones are identified with an identification label stuck on the antenna.

2.3.1 Illustration



2.3.2 Description

- a : IMEI (bar code),
- b : IMEI (15 characters)
- c : Reference of product / aesthetic used (bar code)
- d: Reference of product / aesthetic used (9 characters)
- e :Module serial number (bar code)
- f: Module serial number (10 characters),
- g : Date code + Manufacturing level + Production area Indication,
 Ex. F274/02 = (F) fabrication area (F : Fougères), (274) day of year, (02) last digit of year (02→2002).
 Ex: B254: Manufacturing level
 Ex: Made in China: Production area Indication
- h : Product designation
- i: Sim card Indication (Sim 3V...)

2.3.3 *Description after repair*

A new sticker is positioning by Repairing Centre near the sim card connector:

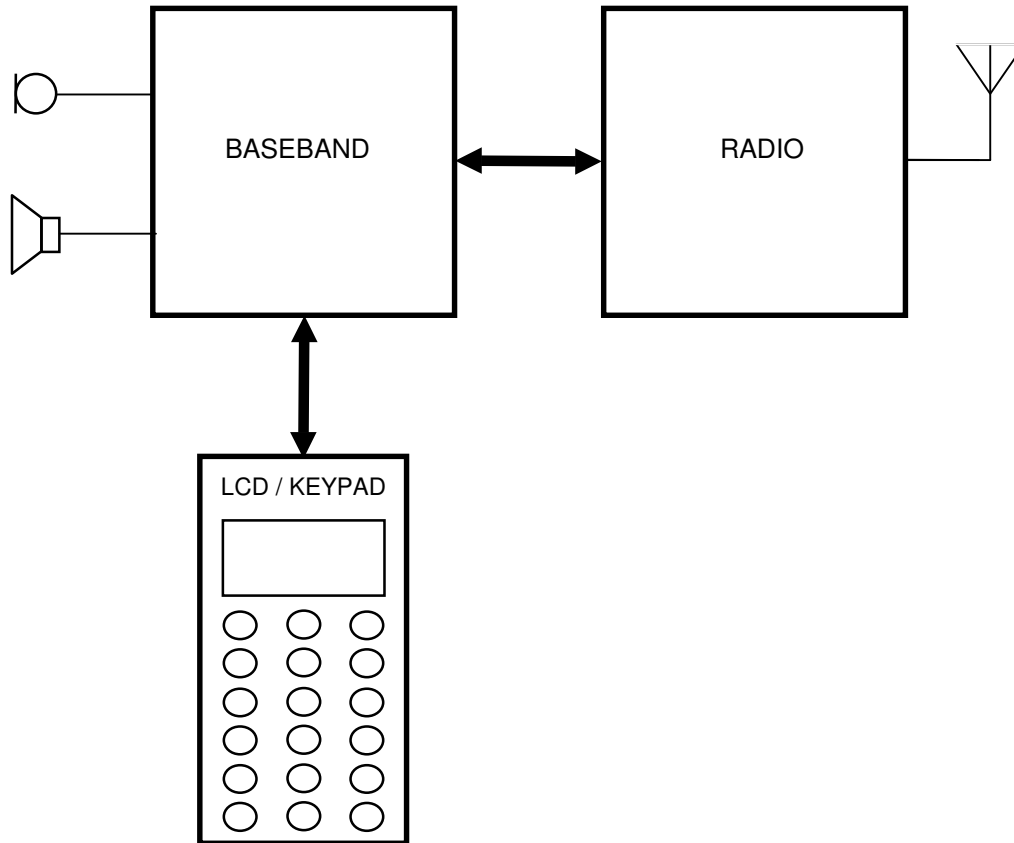


This extra line will appear if the mobile has already been repaired.

- **CRA XXX** ⇒ N° of CRA,
- **203/N03** ⇒ Date of repair: (203) repairing day, (03) last digit of year (03→2003).

2.4 PHONE BLOCK DIAGRAM

2.4.1 myC-1 block diagram



2.4.2 Standards and environment

Conformance Document

SAGEM SA declare under its sole responsibility that the product Dual Band GSM/DCS Type B2003 conforms to the

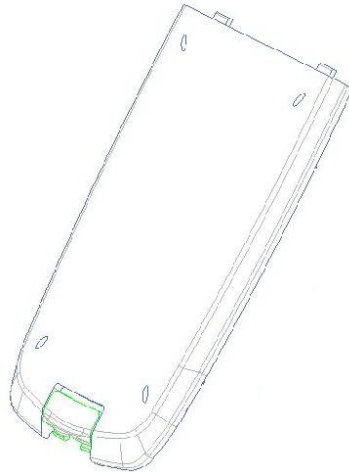
requirements of the following EEC directives:

EEC Directive	1999/5/CE
Safety	EN 60950
EMC	EN 301 489-1 / EN 301 489-7
Low voltage directive	73/23/CEE
Network	3GPP TS 51.010-1 v 5.2.0 selected with GCF-CC v 3.10.0 included
Requirements	GT01 v 4.7.0 / TBR 19 Edition 5 / TBR 20 Edition 3 / TBR 31 Edition 2 TBR 32 Edition 2 / EN 301 419-1 / EN 301511
Health	EN 50360 / EN 50361

2.5 EQUIPEMENTS

The description and operation of SAGEM myC-1 are given in the "User's handbook" supplied with the phone. This chapter only describes equipment that operates with the myC-1 phones .

2.5.1 Battery packs



Over view

2.5.1.1 Characteristics

Technology	Weight	Voltage capacity
Li-ion	22g	3,6 V / 550 mA/H

2.5.1.2 Description

Li-ion type batteries are used. They are rechargeable using:

- mains power supply modules,
- 12 V / 24 V, cigar lighter chargers,
- car handsfree kits (compact and comfort),
- Power supply data.

Batteries caution use:

- Store the batteries in a dry and cool place (excessive cold and heat damage the batteries reliability).
- They must never be stored in bulk, even the rejects, to avoid any short circuits.
- Do not dismantle the battery packs. (Li-Ion regulations).
- Only use original mains power supply module.
- **All the out of order batteries must be returned to SAGEM.**

2.5.1.3 Charging time

The following table shows typical charging times for different batteries.

Battery	500 mA regulated chargers	"Simple" unregulated chargers 230 V Nom. (110 V Nom.)
Li-ion	2h	2h50

2.5.2 Mains modules

2.5.2.1 Description

These mains power supply modules accept large dynamic variations in the power supply network. They are available for a number of connector types:

- E.U,
- United Kingdom
- United States,

2.5.2.2 Travel mains modules

Designation	Weight (g)	Vol (cm ³)	Primary voltage
<i>UNREGULATED TRAVEL MAINS POWER SUPPLY MODULES 6.5 V. 500 mA.</i>			
TRAVEL 500 mA. EC	100	75	110/230 V
TRAVEL 500 mA. UK	110	90	110/230 V
TRAVEL 500 mA. US	125	65	110/230 V

2.5.2.3 Mains modules

Reference	Weight (g)	Vol (cm ³)	Primary voltage
<i>SIMPLE UNREGULATED MAINS POWER SUPPLY MODULES 1.5 V. 300 mA.</i>			
EC MAINS MODULE	180	85	230 V
UK MAINS MODULE	180	120	230 V
US MAINS MODULE	210	105	110 V

CHAPTER 3 - SYMPTOMS

3.1 GENERAL

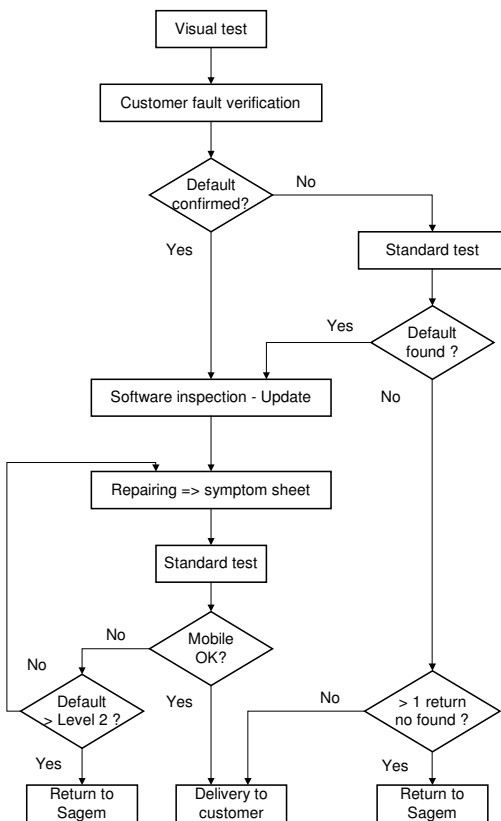
After you have received the **customer return sheet** ([Proc Sheet 3 02](#)), carry out the troubleshooting procedure.

This chapter will help you to identify the defective element(s), using the troubleshooting table.

It contains flow charts broken down by fault type. Each flow chart describes the procedure to be followed and contains cross references to tests or maintenance.

The conclusion of each troubleshooting procedure is :

- Return to SAGEM =The Return to the SAGEM centre can concern either the card, or the radiotelephone according to instructions given to the Centres of repair.
- Delivery to the customer



Visual test :

- Glass state
- Keypad state (elastomer, inscription)
- Connector state (battery, SIM)
- Plug and position of battery
- SIM card position
- Oxidation

Standard test :

- Display test : Hot Line menu
- Contrast control
- All keypad keys test (check bips keys)
- Audio and radio test
- Battery charge test
- Consumption of mobile in off state
- Vibrating device test : Hot Line menu
- Charger test
- Real call with a operator SIM card

These flow charts should be followed in full. After a reference to a removal/replacement sheet or to a test to be carried out, you should return to the initial flow chart and continue the search until reaching a final conclusion.

3.2 LIST OF REPORTED DEFECTS

The following is a list of defects that may be reported :

Code	Indicated fault	Procedure
A0	Display malfunction	Symp Sheet 04
A1	No power up	Proc Sheet 2 08 or 3 01
A2	No display up	Symp Sheet 04
A3	Freezes up	Proc Sheet 2 08 or 3 01
A4	Back lights problem	Proc Sheet 2 08 or 3 01
A5	Broken LCD	Symp Sheet 04
A6	Line or digit missing	Symp Sheet 04
B0	Power supply / no charge	Symp Sheet 01
B1	Defective battery contact	Proc Sheet 0 01
B2	Defective charger connector	Proc Sheet 2 08 or 3 01
B3	Defective board power supply	Proc Sheet 2 08 or 3 01
B4	Defective charge icon display	Proc Sheet 2 08 or 3 01
B7	Autonomy	Symp Sheet 01
B8	Electrically defective battery	Test Sheet 02
B9	Mechanical lock problem on battery	Proc Sheet 0 01
B10	Broken battery	Test Sheet 02
B11	Defective charger	Test Sheet 01
B12	Broken charger	Test Sheet 01
B13	Intermittent cut with reboot	Proc Sheet 2 08 or 3 01
B14	Intermittent cut without reboot	Proc Sheet 2 08 or 3 01
C1	Not functioning keyboard	Symp Sheet 05
C2	Lateral key problem	Symp Sheet 05
D1	Sim missing	Proc Sheet 2 08 or 3 01
D2	Other messages	Proc Sheet 2 08 or 3 01
D3	EEPROM pb	Proc Sheet 2 08 or 3 01
D4	Untuned mobile	Proc Sheet 2 08 or 3 01
D5	Hard failure	Proc Sheet 2 08 or 3 01
D6	Sim lock	Proc Sheet 2 08 or 3 01
D7	Post code	Without object
D8	Return SAV	Proc Sheet 2 08 or 3 01
D9	Unknown battery	Test Sheet 01

Code	Indicated fault	Procedure
E1	Defective loudspeaker (hails)	Symp Sheet 08
E2	Loudspeaker voice distortion	Symp Sheet 08
E3	Defective microphone	Symp Sheet 08
E4	Microphone voice distortion	Symp Sheet 08
E5	Vibrating device malfunction (depending on models)	Symp Sheet 07
E6	Defective audio connector	Symp Sheet 08
F1	No network localisation	Symp Sheet 02
F2	Intermittent calls drop	Symp Sheet 02
F3	Network temporary drop	Proc Sheet 2 08 or 3 01
F4	Radio test not ok	Proc Sheet 2 08 or 3 01
F5	Outgoing call failure	Symp Sheet 02
F6	Incoming call failure	Symp Sheet 02
G1	Broken or damaged glass	Proc Sheet 2 03/ 2 04
G2	Broken or damaged cover	Proc Sheet 1 01 /2 03/ 2 04
G5	Broken or damaged keyboard	Proc Sheet 1 02
H1	DATA PROBLEM (SMS, EMS, SMS,GPRS, WAP, DOWNLOADING GAMES, RINGING TONES, SCREEN SAVER, NO COMMUNICATION WITH A PC, POCKET PC or PALM)	Without object
H2	Video function	Without object
H3	INFRARED function (IRDA)	Without object
I1	Oxidation marks	Proc Sheet 2 08 or 3 01
I2	FM function	Proc Sheet 2 08 or 3 01
I3	Monetic function	Proc Sheet 2 08 or 3 01
I4	Broken or damaged accessory	Proc Sheet 2 08 or 3 01
I5	Defective SIM connector	Proc Sheet 2 08 or 3 01
I6	Malfunction of the menu	Proc Sheet 2 08 or 3 01
I7	Lack function in the menu	Proc Sheet 2 08 or 3 01
I8	No fault found	Symp sheet 03

3.3 ERROR MESSAGES DURING START UP

<i>Message</i>	<i>Meaning</i>	<i>Procedure</i>
WARNING UNTUNED RADIO	Invalid EEPROM field (SAGEM)	SAGEM Factory Return
PB IMEI	Consistency problem at IMEI level	SAGEM Factory Return
SIM MISSING	SIM card missing or badly inserted	Insert the SIM card
IMEI ERROR	Consistency problem at IMEI level	SAGEM Factory Return
UNTUNED	Mobile not configured	SAGEM Factory Return
UNKNOWN BATTERY	Battery not recognised by the mobile	Replace the battery
MOBILE PHONE LOCKED	Number of seizures of sim locked code exceeded	SAGEM Factory Return Not repair under warranty
SIM BLOCKED	Three bad PIN codes have been input	Contact the operator
SIM LOCKED (with SIM)	SIM card not adapted to the operator	Replace the SIM card
SIM LOCKED (without SIM)	Attempt of corruption (EEPROM fields)	SAGEM Factory Return Not repair under warranty
BATTERY TOO LOW	Battery state	Replace the battery

3.4 OTHER ERROR MESSAGES

<i>Message</i>	<i>Meaning</i>
"LINE INCIDENT"	Fax & PC link type "Problems"
"FULL MEMORY"	Fax & PC link type "Problems"
"CLEARING REJECTED"	Fax & PC link type "Problems"
"CHECK CONNECTION"	Fax & PC link type "Problems"
"NOT CONSULTED DOCUMENT"	Fax & PC link type "Problems"
"DEVICE PROBLEM"	Fax & PC link type "Problems"
"VERIFY APPLICATION"	Fax & PC link type "Problems"
"BUSY"	"Problems" related to the network and Communications
"K.PAD LOCKED PRESS *V"	Keypad locked
"OPTION NOT AVAILABLE"	Menu not available for this product version
"PROG.KEY NOT VALID"	Input "Problems"
"ERROR!!"	Calculation error with the calculator (division by zero)
"NOT REACHABLE"	Call forwarding if the mobile is not reachable
"NOT AVAIL."	Not available
"PIN ERROR"	" PIN input problems "
"PIN2 BLOCKED"	Following input errors
"PUK ERROR"	Following input errors

<i>Message</i>	<i>Meaning</i>
"PUK2 BLOCKED"	Following input errors
"CODE ERROR"	The phone code input for locking the mobile is incorrect
"NOT AVAIL."	Service not implemented in the network
"TRY AGAIN"	Following a network problem
"NETWORK BUSY"	"Problems" related to the network and Communications
"WAIT"	"Problems" related to the network and Communications
"UNBLOCK?"	"Problems" related to the SIM card
"MEMO REC. CUT"	Save during storage in the answering machine truncated due to lack of space
"FUNCTION NOT ALLOWED"	Prohibited function requested
"NOT FOUND"	Unsuccessful search (on directory, etc.)
"BUSY"	"Problems" related to the network and Communications
"REJECTED"	The requested operation was refused by the network
"EMPTY"	Empty (note pad, memo, etc.)
"NOT IN GROUP"	Error display following an error code returned from the network (CUG menus)
"CREDIT END"	"Credit end" information (paying call prohibited)
"CREDIT TOO LOW"	"Credit too low" information (CUG menus)
"NO AUTHORIZED ACTION DURING A WAP CALL"	Not available action during a wap call
"NOT CONFIGURED ACCESS"	Selection of a not configured provider
"UNKNOWN ACCESS"	Selection of a not fully configured provider
"UNKNOWN CALL IN PROGRESS"	Selection of a provider during a call in progress
"NO RESPONSE OF THE SERVER"	" Problems" related to the server
" NO RESPONSE OF THE NETWORK"	"Problems" related to the network and Communications
"NOT AVAILABLE NETWORK"	"Problems" related to the network and Communications
"TOO LONG URL ADDRESS"	The address typed is too long

3.5 LIST OF OBSERVED DEFECTS

A SAGEM code is assigned to each confirmed defect. This code should be entered on **Proc Sheet 3 01, SAGEM Factory Return**, if the phone to be repaired is returned to SAGEM (**see chapter 5**).


3.6 NEW PROBLEM DETECTED PROCEDURE

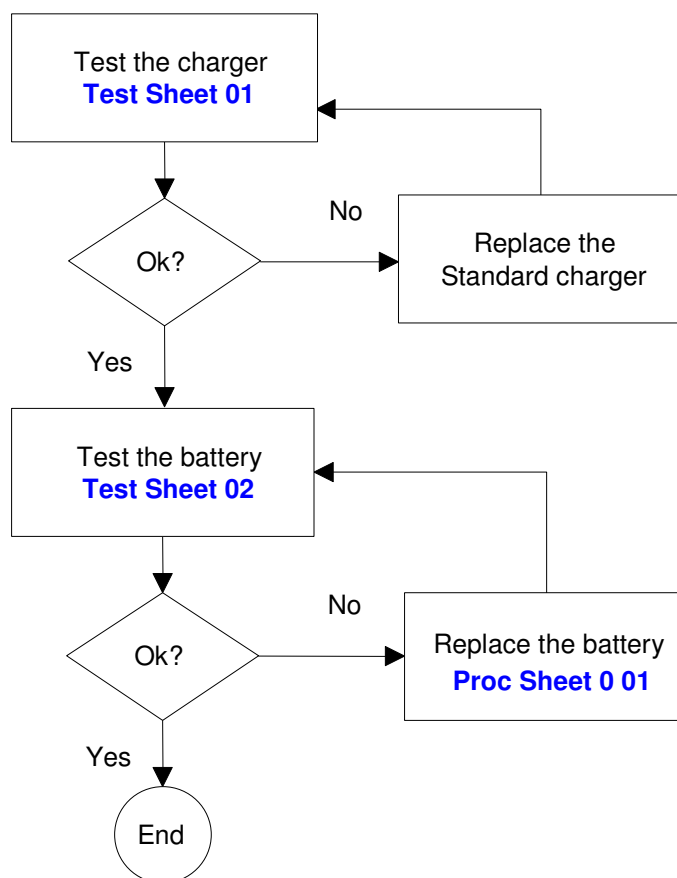
When a new problem is detected:

- 1- The concerned technician fills a precise report using the document located in the ARC Kit : NPD report SAV GSM 277 V1.doc (see ANNEX A2.doc)
- 2- Then, this document is transmitted by email to the concerned Area Manager or Support Engineers for approval. Accordingly, 2 ways are possible :
 - The problem is already known by SAGEM, then the mobile have to follow the normal process in ARC with eventual additional data given by AM or SE
 - Return of mobile to MTB is requested.
- 3- In that second case, the ARC will have to request a specific RMA number for this mobile in order to facilitate the treatment when arriving in MTB.
- 4- This mobile returned to MTB will be swapped following ARCs habitual process for MTB return but will be MANDATORY linked to a paper version of the document filled by the technician.
- 5- The treatment will have to be reproduced on the daily report and will be considered as level 3. Specified fault code will be then the technically closest one of the noted one, in the grid given by SAGEM

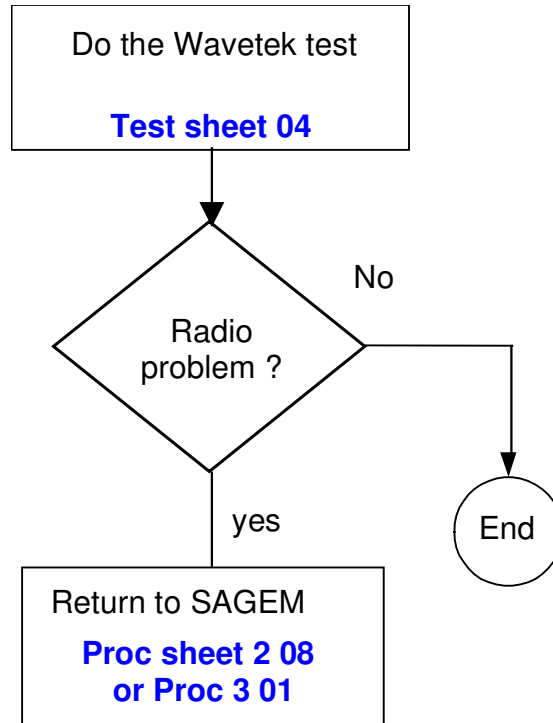
The goal of this chapter is to define the successive stages to respect imperatively for the new problem detected gone up in ARC and still unidentified by SAGEM

SYMPTOM SHEETS

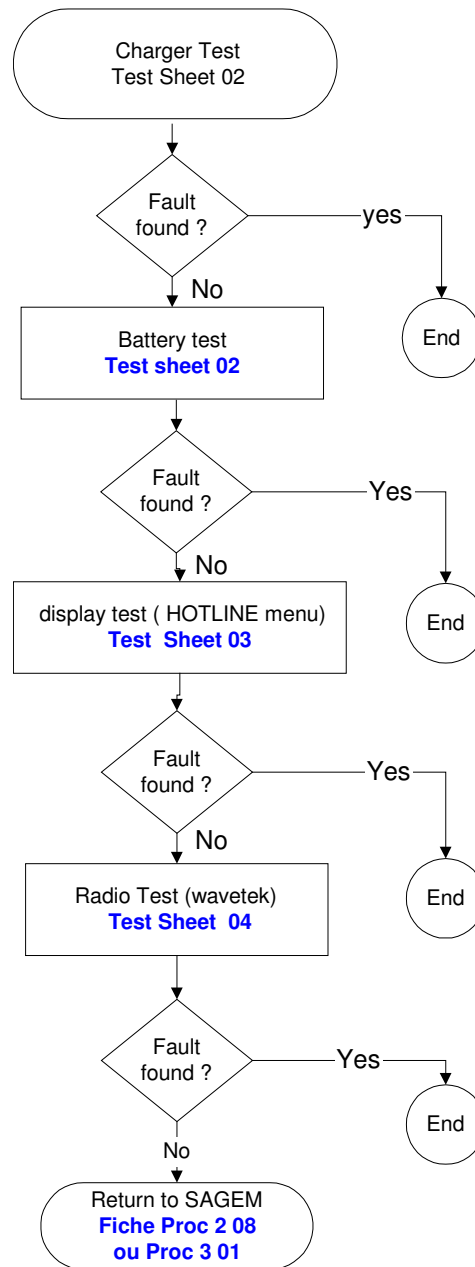
 SAGEM	ENDURANCE, BATTERY, CHARGER PROBLEM	Symp Sheet 01
myC-1		1/1



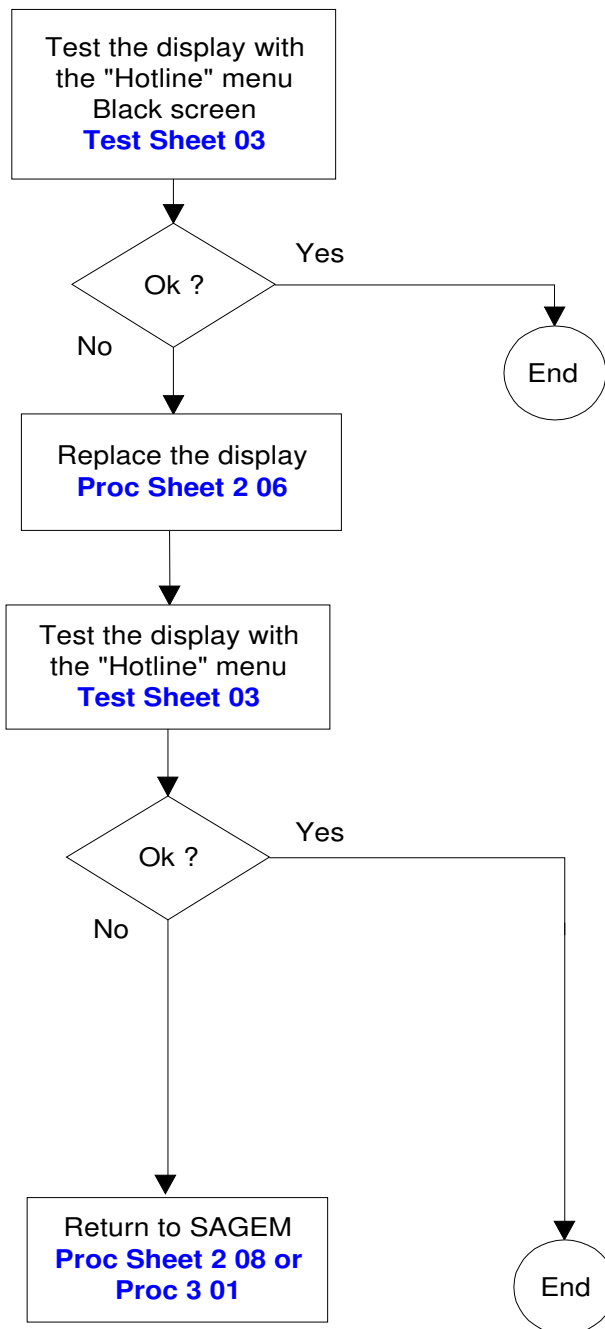
 SAGEM	COMMUNICATION PROBLEM	Symp Sheet 02
myC-1		1/1




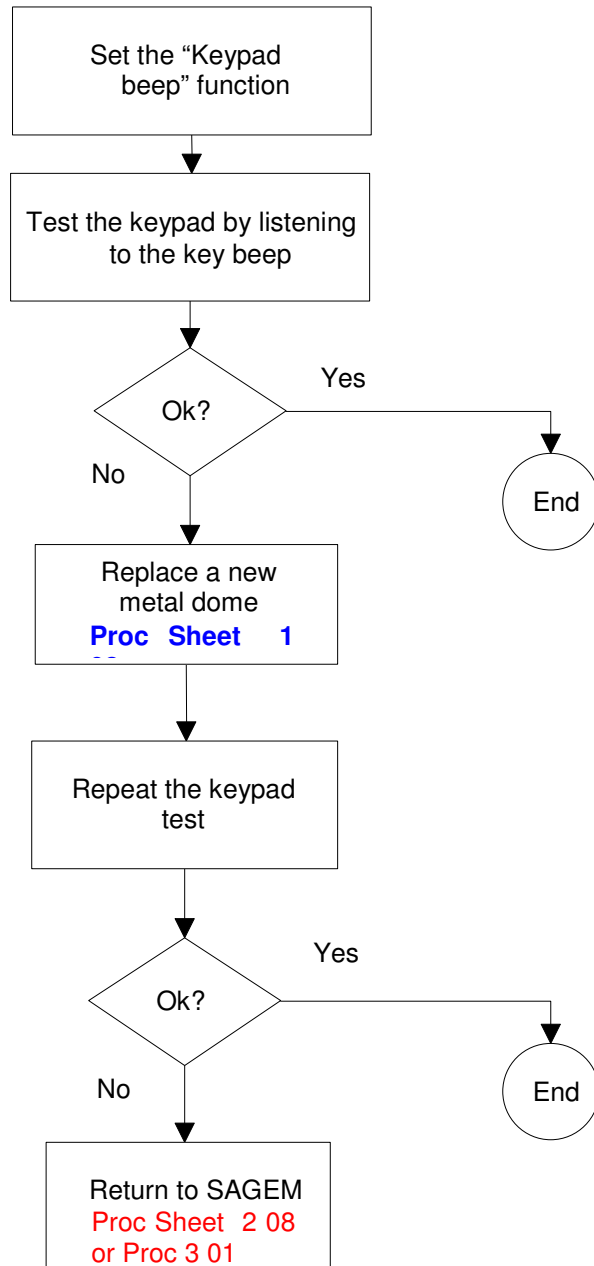
 SAGEM	NO FAULT GIVEN (Mobile expertise)	Symp Sheet 03
myC-1		1/1




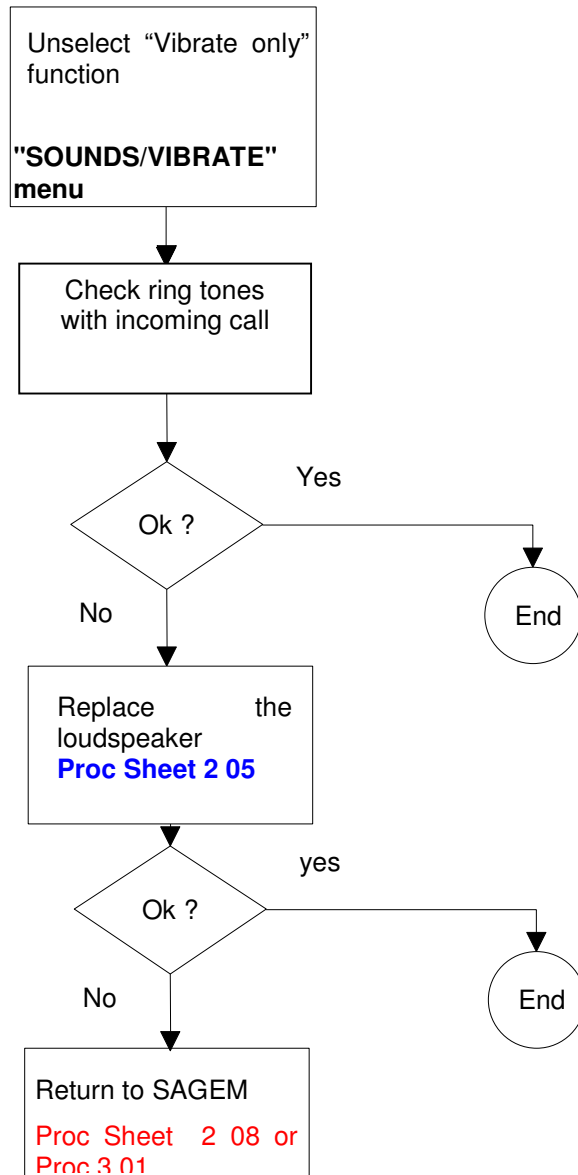
 SAGEM	DISPLAY PROBLEM	Symp Sheet 04
myC-1		1/1



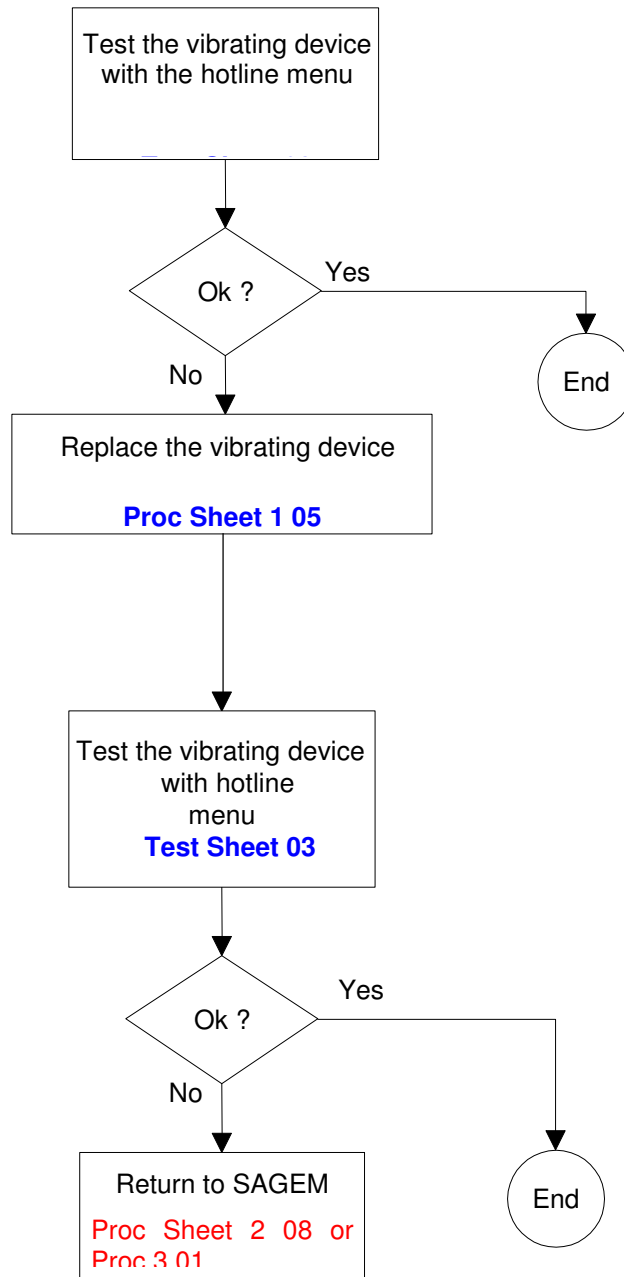
 SAGEM	KEYPAD PROBLEM	Symp Sheet 05
myC-1		1/1

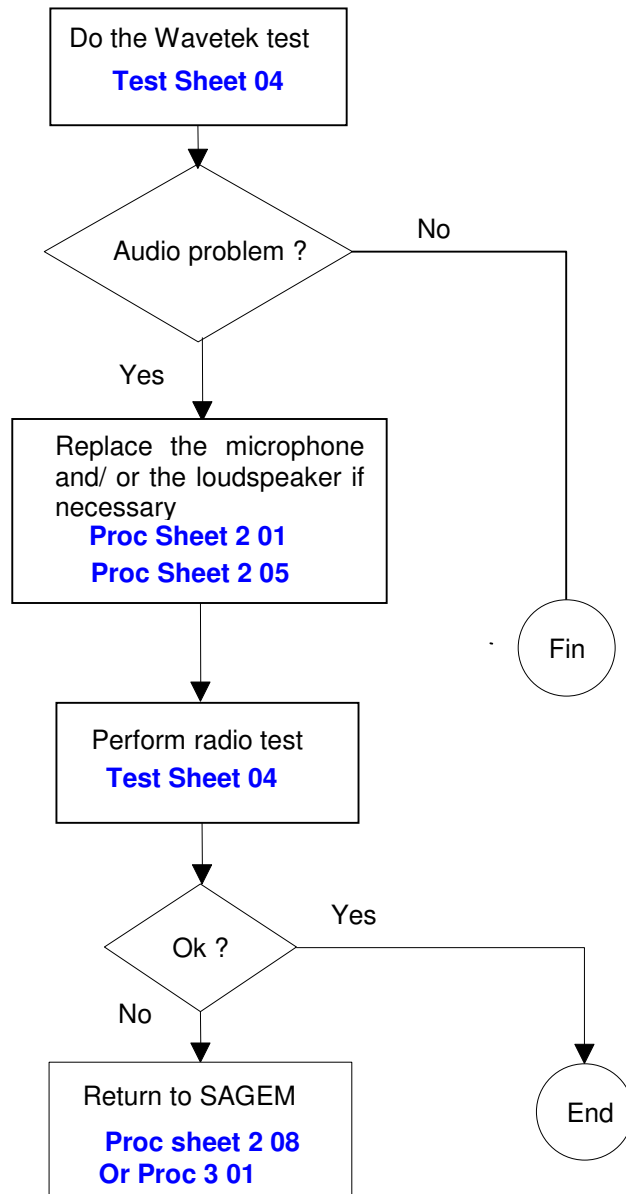


 SAGEM	RING TONES PROBLEM	Symp Sheet 06
myC-1		1/1



 SAGEM	VIBRATING DEVICE	Symp Sheet 07
myC-1		1/1





CHAPTER 4 - TESTS AND CHECKS

4.1 ABOUT TESTS

Tests and checks are made after the troubleshooting procedures (chapter 3) and before the maintenance procedures (chapter 5).

They are broken down into modules and are sorted by types of confirmed faults. The user must be equipped with special test tools in order to carry out the tests.

4.2 TEST TOOLS

The references of SAGEM tools, listed hereafter, are given in Appendix 1 : Composition table.

The following test tools are necessary :


CHAPTER 5 - **the radio test bench**, provided with:

- SIM card of test.
- MyC-1 calibration tool
- Adjustable regulate power supply 0-15V / 4A
- Wavetek 4107
- **CADEX C7000 / C7200 / ASTRATEK** with myC-1 adapter
 - Charger test kit
 - Ammeter interface myC-1
 - Voltmeter (minimum impedance : 20 K Ω per Volt in DC)
 - Ammeter

CHAPTER 6 - **an IMEI labels printing station**, including :

- Printer,
- Roll of labels,
- Connecting cable for PC (parallel printer cable),
- Printing software,

TEST SHEET


 SAGEM	CHARGER TEST	Test Sheet 01
myC-1		1/1

Test description

This test checks the various battery chargers.

Test procedure

1. Check visually the charger connector.
2. Connect the charger to be tested to the mobile .
3. Access to the "HOTLINE" menu by pressing on the ▼ key and then the * key.
4. Select the APPLICATION menu and the BATTERY STATUS to check that the battery voltage is increasing

 SAGEM	BATTERY TEST	Test Sheet 02
myC-1		1/1

Test description

This test allows to test the various batteries.

Required tools

- CADEX C7000 / C7200 / ASTRATEK
- myC-1 adapters,
- myC-1 Ammeter interface
- a voltmeter (minimum impedance 20 k Ω per Volt in DC).

Test procedure

1. Insert battery on ammeter interface
2. Measure the identification resistor between the Z poles :
3. Li-Ion batteries : **120k Ω (tolerance = 117k Ω - 123k Ω** , according to the surrounding temperature)
4. Measure the battery voltage between the V poles, **the voltage shown must be between 2.5V and 4.5V.**
 - If the voltage < 4v ,load the battery for 30 minutes with a travel charger and follow the instructions below
 - If the voltage > 4V Measure the internal resistance with a CADEX or ASTRATEK batteries testers
 - **Notice:** Choose on the batteries tester ,the battery type (Li-ion) ,the nominal battery voltage (3,6V) and the battery capacity (550 mA)
 - Read the result :If the internal resistance < 300 mOhms the battery is **OK**
 - If the internal resistance = 300 mOhms the battery is **defective**

 SAGEM	"HOTLINE" MENU	Test Sheet 03
myC-1		1/1

Access to the "HOTLINE" menu

Access to the "HOTLINE" menu is possible with a powered up mobile.

The "HOTLINE" menu is accessed by pressing on the ▽ key and then the * key.

Enter the corresponding code (bold) to choose the menu to be viewed.

To go out the "HOTLINE" menu, press successively on the C key to return at the operational screen of the mobile.

Description of the myC-1 "HOTLINE" menu

1 APPLICATION

- BATTERY : gives the value of the battery voltage.
- VERSION : reads the installed software version and the IMEI code.

2 PROM : Not used

3 SIM LOCK : accesses the "SIM LOCK" menu (password required).

4 TESTS LCD

- CHECKERBOARD
- INVERTED CHECKERBOARD
- BLACK SCREEN : displays the screen in black.
- PHOTO: functions on the screen to showing a picture.
- VIBRATE: tests the vibrating device.

NOTE : The "HOTLINE" menu is only accessible with a valid SIM card.

Test description

This test tests myC-1 phones during a call.

Required tools

- A Wavetek
- A RF coupler or a myC-1 interface.
- A myC-1 calibration tool
-

Test procedure

1. Position the calibration tool first on the RF coupler to calibrate it
2. Position the myC-1 module on the RF coupler
3. Switch the Wavetek on and press on "AUTOTEST".
4. Choose the corresponding program using the "UP" and "DOWN" arrows.
 Mobile : **myC-1**
 Frequency range : **GSM, DCS or GSM/DCS**,
 Coupling type : **CABLE**.
5. Press on "ENTER" and wait until the end of the calibration.
6. Follow the instructions shown on the Wavetek.

CHAPTER 5 - MAINTENANCE PROCEDURES

TECHNICAL WORK LEVELS

There are four technical work levels:

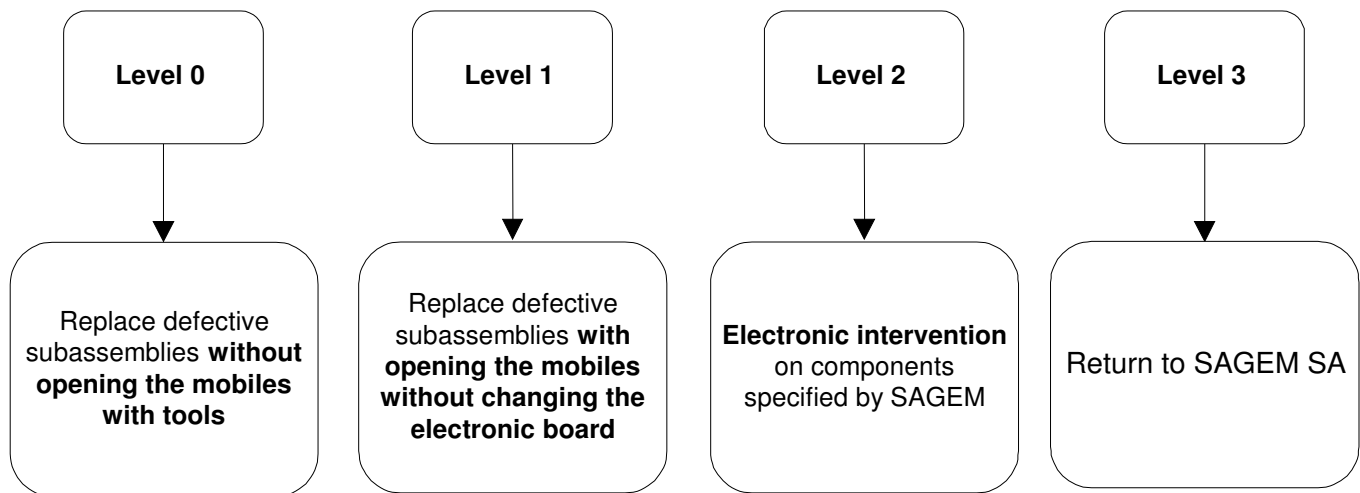
Level 0,

Level 1,

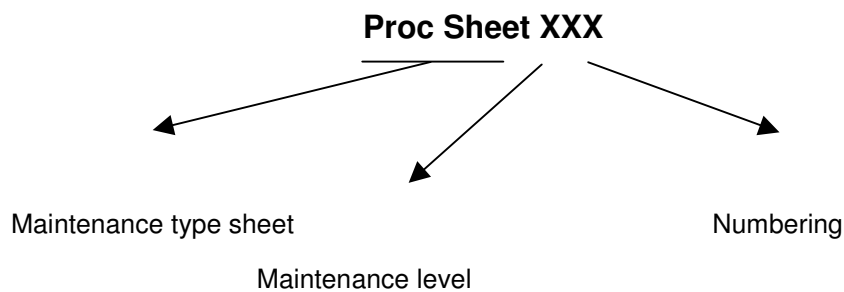
Level 2,

Level 3.

Each level represents a maintenance degree that depends on which elements are to be removed.



Maintenance procedure sheets are coded as follows :



5.2 SHORT LOOP PROCESS

1. Initialisation

From the communication by Sagem and the reception of the concerned products by the short loop process, the Repair Centre shall comply with the above procedure. The application of the Short loop process will end when received the authorisation of repairing given by Sagem.

2. Administrative checks to be done by the Repair Centre

- Authorisation from Sagem for treating the reference received (Part number)
- Process to be applied : short loop process or normal process (DTS, Normal, etc...). The Repair Centre shall check if the product received has to be treated according to the short loop process.
- Controls on the warranty conditions and DOA conditions (if the Repair Centre is authorised) communicated by Sagem.

3. Tests and controls :

- Checks if there are no external shocks or oxidation marks (the covers shall be dismantled in case of exchangeable covers)
- Checks and confirmation of the defect (real call with SIM, functional test keypad , display, vibrating device, etc...)
- Check the concordance between the defect declared by the end-user and the defect observed
- Call back of the end-user or dealer (as far as possible) either in case of misunderstanding of the defect declared by the end-user or in case of the non observation of the defect. (see the appendix "Additional information about the No Fault Found –NFF- " at the end of this document allowing according to the case to understand the return of the product)

If any doubts occurred concerning out of warranty products received, the Repair Centre shall send to Sagem Montauban (with knowledge to the Area Manager and Support Engineer) the photo of the defect.

N.B :

- The handsets shall not be dismantled (by using screwdrivers) except previous request from Sagem.
- The Repair Centre will not make any Repair (such as spare parts exchange or software upgrade) except previous communication of Sagem. The exchanges of handsets or accessories are the only intervention authorised.

4. Exchange by the Repair Centre

- The Repair Centre will use the products delivered for swap to the Repair Centre for exchanging the products to the end-users (except particular process defined by Sagem).
- The under- warranty handsets and accessories received shall be exchanged to the end-user.

- The under- warranty handsets and accessories declared No Fault Found (NFF) shall be exchanged to the end-users except previous communication of Sagem.
- The Out of warranty handsets and accessories (oxidation, shocks, ...) will be repaired by the Repair Centre after acceptance by the customer of an estimate according to the Sagem out of warranty repair prices communicated.
- **The under- warranty and out of warranty handsets shall be sent to Sagem Montauban.**
- In the frame of the Short loop process, there is no level 1 (L1) intervention

5. Reports

An exchange of an handset and its accessories shall be codified Level 3 (L3)

An accessory exchange shall be codified Level 0 (L0).

The Repair Centre shall capture all the information required for issuing and sending the Repair Reports and Status reports according to the Contractual frequency defined. The Reports shall includes the products treated by the Repair Centre under- warranty or out of warranty.

6. Procedure

From the beginning date of the Short loop process application and **minimum each week, the Repair Centre shall ship the products (handsets and accessories) to Sagem Montauban.**

61. Handsets :

- MRA Procedure for the after-Sales products (one MRA number for the products concerned by the short loop).
- MRA Procedure for DOA products (one MRA DOA number for the products concerned by the short loop) if the Repair Centre is authorised to treat the DOA products.

The MRA request shall be sent to Sagem Montauban (with knowledge to the Area Manager and Support Engineer).

The shipment of products to Sagem Montauban shall comply with the MRA procedure. Furthermore each products shall be sent with the Return Product Sheet filled in indicating the defect declared by the end-user and the defect observed by the Repair Centre (Sagem Defect codes).

The NFF products sent to Sagem Montauban shall be identified by using separate package. Furthermore this products shall be sent with the complete description of the defect declared by the end-user (not codified).

The accessories received by the Repair Centre shall be sent to Sagem Montauban sent back attached with the handset (not connected to the handset).

62. Accessories :

For the accessories received without the handsets, the procedure is the following:

Accessories return procedure to Sagem Montauban to be used. The Repair Centre shall indicate on the parcel Accessories + model (ex : myX-6) for the accessories received in the Repair Centre without the handsets.

7. Sagem Montauban

Sagem Montauban will ship back to the Repair Centre the same quantity of handsets and accessories as the quantity received.

8 Additional information about the no fault found

In any case: Ask to the end-user the frequency of the defect and the circumstances of its apparition (during an incoming or out-going call, while playing, while downloading, etc.). Try to answer the questions: Where? When? How?

- If the customer complains about a **“Power supply / charging”** failure : (shutting down of the mobile, problem of booting, etc.);
 - During which operation ? In which circumstances ?
 - What is the state of the battery and the charger before shipment to the repair centre ?
 - If the mobile shuts down by itself, must he enter his code pin, adjust the date and the hour when rebooting the phone?
- If the customer complains about a communication problem:
 - What are his residence zone and the reception level of the mobile (Number of receipt bar);
 - What is the state of the battery when the defect appears?
 - In case of loss of communication :
 - With or without total extinction of the mobile?
 - Does the loss of communication occur always in the same place and with the same person?
 - Does the loss of communication occur while browsing in the menus, during the communication, or during playing or downloading?
- If the customer complains about a problem of blockage of key of the keyboard:
 - In which circumstances does the problem occur?
 - Did he activate the keypad locking ?
 - Did he change or remove the upper cover ?
 - Which are the non functioning keys ?

MAINTENANCE TOOLS

The following tools are necessary to carry out maintenance operations :

Electrical screwdrivers with tightening torque settings **(0.25 NM)** ,equipped with 0,6 mm Torx .

Metal dome jig.

Plastic Tweezers.

Gloves

ESD protection strap

Soldering iron

Flat screwdriver 2x75

LEVEL 0 MAINTENANCE

 SAGEM	REMOVING / REPLACING THE BATTERY	Proc Sheet 0 01
myC-1		1/2

6.1 Tools :

6.2 - Not applicable

6.3 Preliminary operation :

6.4 - Switch off the mobile phone

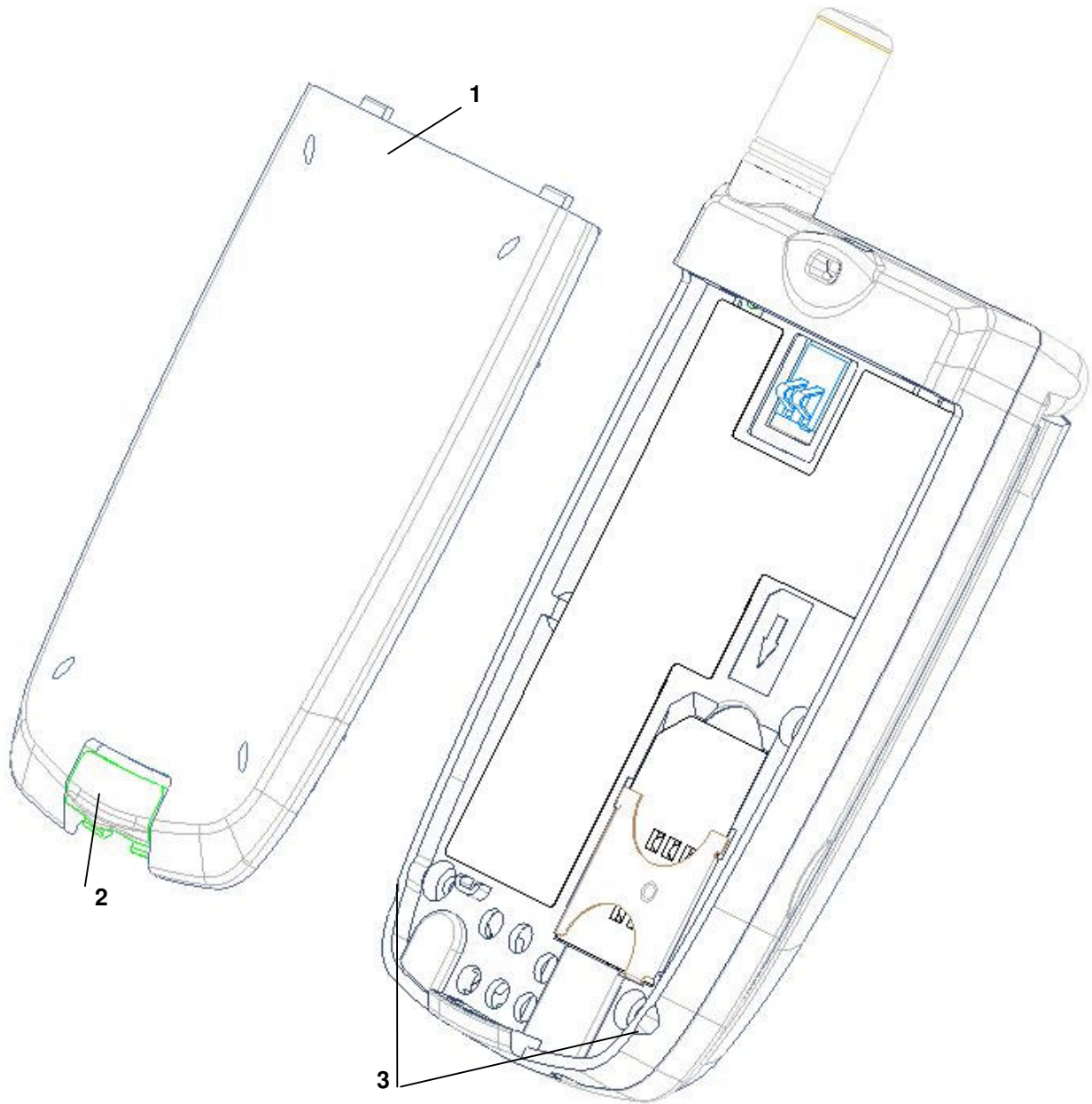
6.5 Removal procedure :

1. Unlock the battery pack (1) , by pushing the lock button (2) upwards and extract it by mean of two nicks (3).
2. Take out the battery (1) by first extracting the lower section.

6.6 Placement procedure :

1. Replace the battery pack (1) by engaging top hooks first .
2. Push button (2) upwards and push down back of battery pack into locked position

 SAGEM	REMOVING / REPLACING THE BATTERY	Proc Sheet 0 01
myC-1		2/2



 SAGEM	REMOVING / REPLACING THE BATTERY	Proc Sheet 0 01
myC-1		2/2

 SAGEM	REMOVING / REPLACING THE ANTENNA	Proc Sheet 0 02
myC-1		1/2

6.7 **Tools :**

- Not applicable

6.8 **Preliminary operation :**

1. Switch off the mobile phone

6.9 **Removal procedure :**

1. Unscrew the antenna (1) of the back cover (2)

6.10 **Placement procedure :**

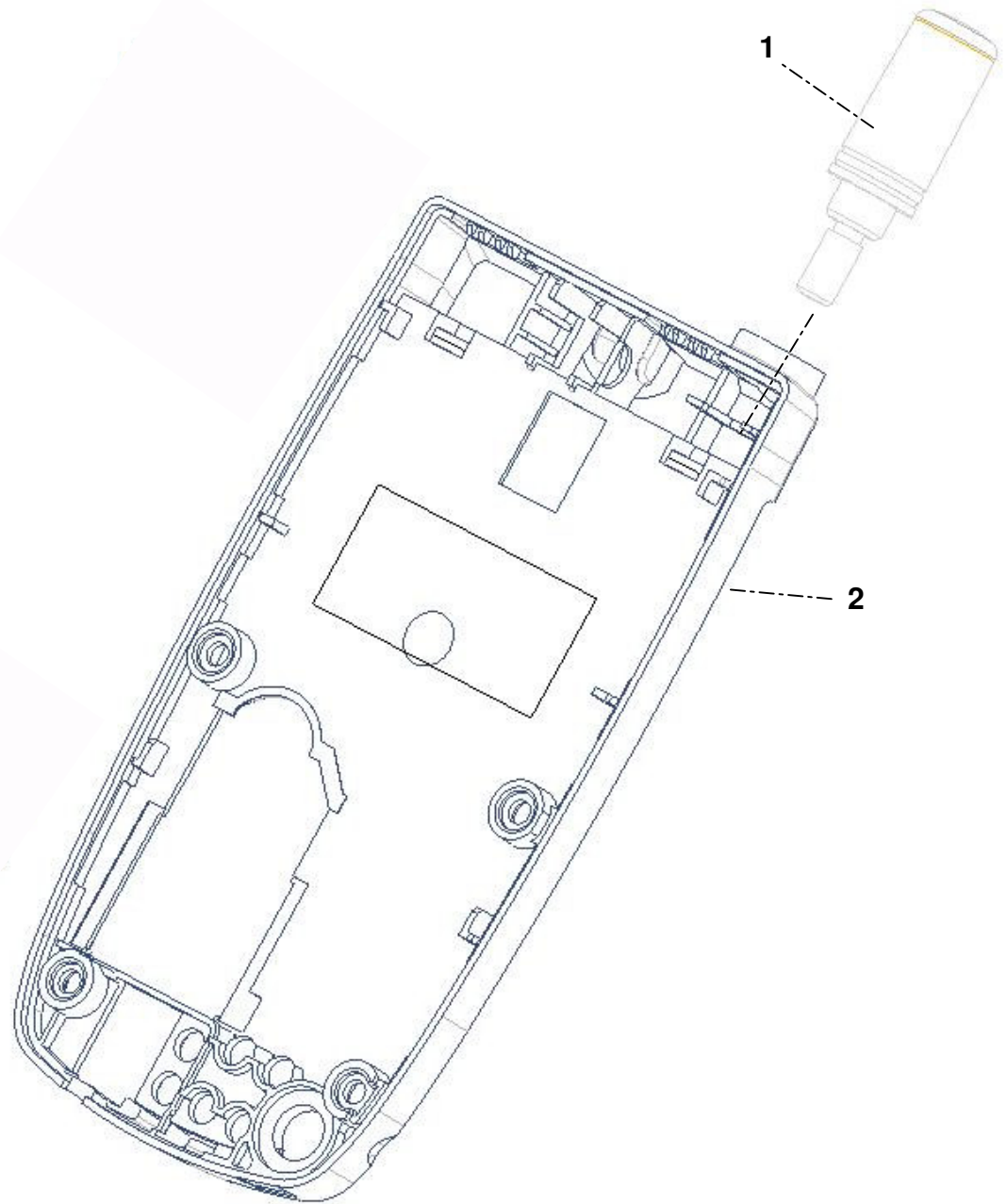
2. Screw the new antenna (1) into the back cover (2)

6.11 **Further operations**

1. Carry out radio test ([Test Sheet 04](#)).

6.12

 SAGEM	REMOVING / REPLACING THE ANTENNA	Proc Sheet 0 02
myC-1		2/2



LEVEL 1 MAINTENANCE

 SAGEM	REMOVING / REPLACING BACK COVER	Proc Sheet 1 01
myC-1		1/2

6.13 **Tools :**

- A 0.6mm torx screwdriver

6.14 **Preliminary operation**

1. Remove the battery pack ([Proc sheet 0 01](#)).

6.15 **Removal procedure :**

1. On the back cover, unscrew the four attachment screws (4) .
2. Lift delicately the back cover (1) up beginning by the lower side
3. Remove rear cover (1)

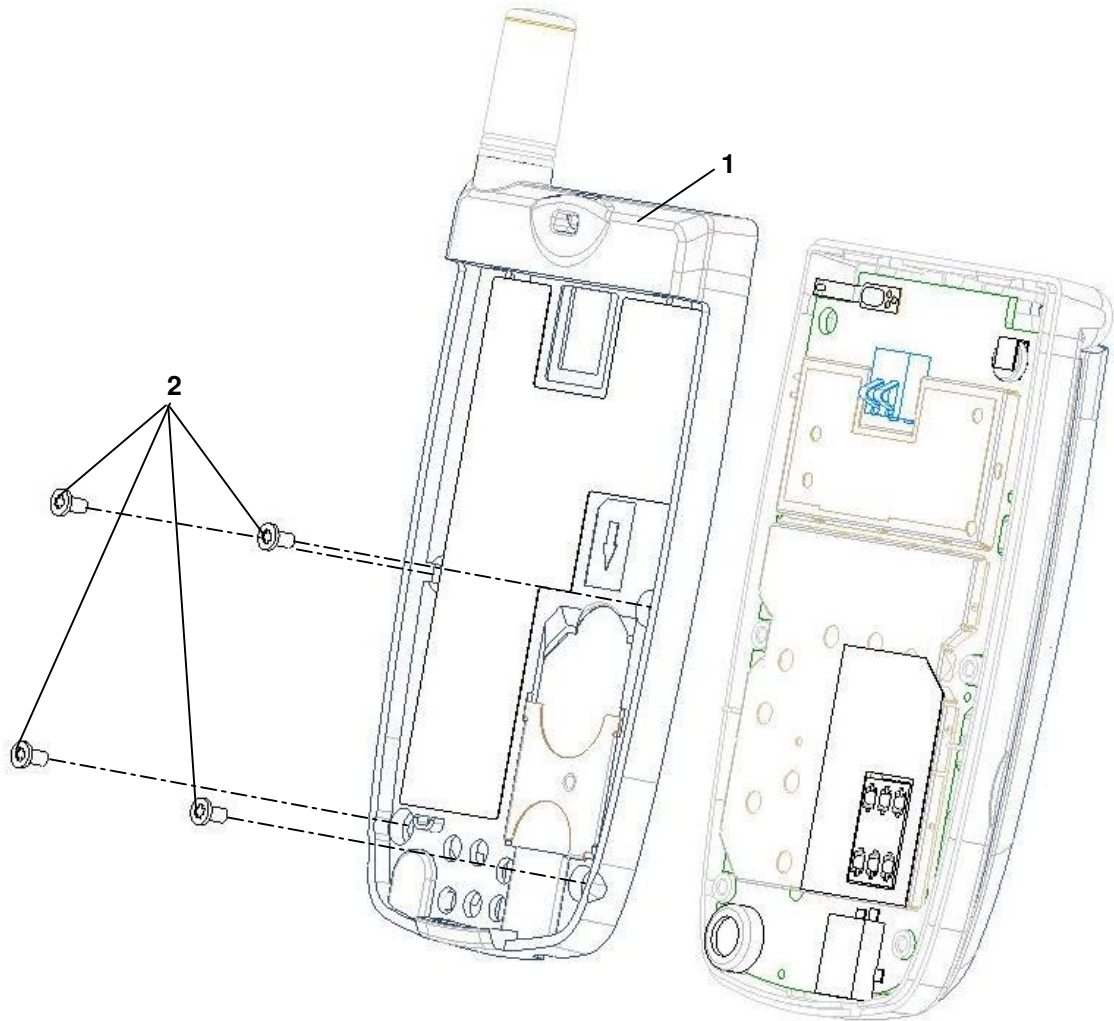
6.16 **Placement procedure :**


1. Replace the cover by engaging top hooks first .
2. Push down back of rear cover and screw the four attachment screws (4) with **0,25 N.m** torque.

6.17 **Further operations :**

1. Replace the battery pack (Proc sheet 0 01)

 SAGEM	REMOVING / REPLACING THE BACK COVER	Proc sheet 1 01
myC-1		2/2



 SAGEM	REMOVING / REPLACING THE ELASTOMER KEYPAD	Proc Sheet 1 02
myC-1		1/2

6.18 **Tools :**

- A 0.6mm torx screwdriver

6.19 **Preliminary operation**

2. Remove the battery pack ([Proc sheet 0 01](#)).
3. Remove the back cover ([Proc sheet 1 01](#)).

6.20 **Removal procedure :**

1. Unstick the ground tape (2) of the radio shielding on the electronic board.
2. Turn the electronic board round to liberate it from the front cover (1)
3. Remove the elastomer keypad (2) from the front cover (1).

6.21 **Placement procedure :**

1. Clean the elastomer keypad (2) with compressed air.
2. Place the elastomer keypad (2) in position in its housing
3. Place the electronic board in its housing
4. Stick the ground tape (2) on the electronic board by fixing correctly on the radio shielding

Nota: If the ground tape have been damaged during operations, change automatically the LCD foam for ESD.

6.22 **Further operations :**

1. Replace the back cover ([Proc sheet 1 01](#)).
2. Replace the battery pack ([Proc sheet 0 01](#)).

 SAGEM	REMOVING / REPLACING THE ELASTOMER KEYPAD	Proc Sheet 1 02
myC-1		2/2



 SAGEM	REMOVING / REPLACING THE METAL DOME	Proc Sheet 1 03
myC-1		1/2

6.23 Tools :

- A 0.6mm torx screwdriver
- Gloves
- Metal dome Jig
- Tweezers

6.24 Preliminary operation

This procedure must be performed by a technician with gloves.

1. Remove the battery pack ([Proc sheet 0 01](#)).
2. Remove the back cover ([Proc sheet 1 01](#)).

6.25 Removal procedure :

1. Turn the electronic board round to liberate it of the front cover
2. Remove the metal dome of the electronic board

6.26 Placement procedure :

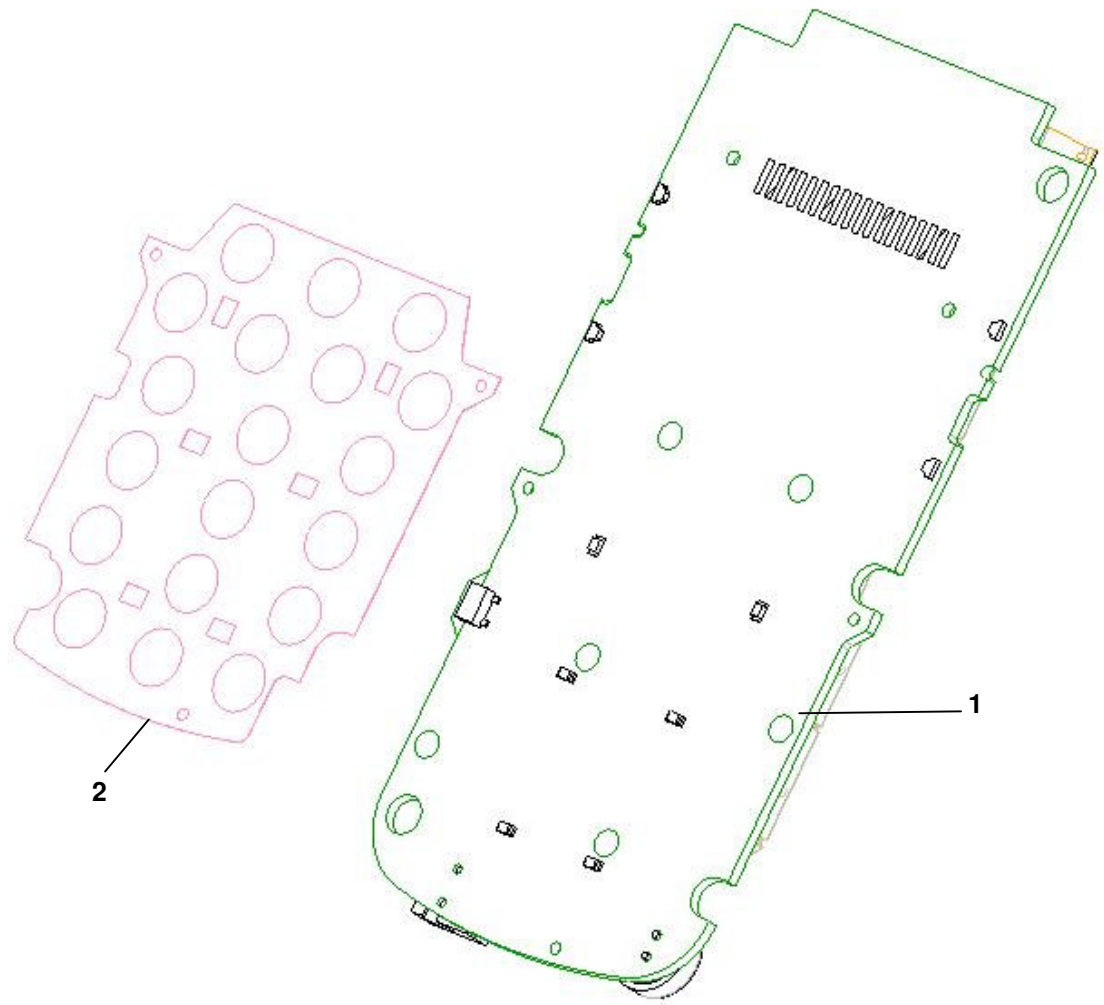
Warning : The metal dome is not reusable, it must be necessarily replaced by a new metal dome, unless the board is swapped and sent as level 3

1. Replace the metal dome on the electronic board, using the metal dome jig.
2. Place the electronic board in its housing

6.27 Further operations :

1. Replace the back cover ([Proc sheet 1 01](#)).
2. Replace the battery pack ([Proc sheet 0 01](#)).
3. Carry out the radio test ([Test Sheet 04](#)).

 SAGEM	REMOVING / REPLACING THE METAL DOME	Proc Sheet 1 03
myC-1		2/2



 SAGEM	REMOVING / REPLACING THE SIM LOCKER	Proc Sheet 1 04
myC-1		1/2

6.28 **Tools :**

- A 0.6mm torx screwdriver

6.29 **Preliminary operation :**

1. Remove the battery ([Proc sheet 0 01](#)).
2. Remove the SIM card .
3. Remove the back cover ([Proc sheet 1 01](#)).

6.30 **Removal procedure :**

1. On the back cover (2), looked at from the battery side ,press firmly the SIM locker (1) until its extraction .
2. Remove the SIM cover (1).

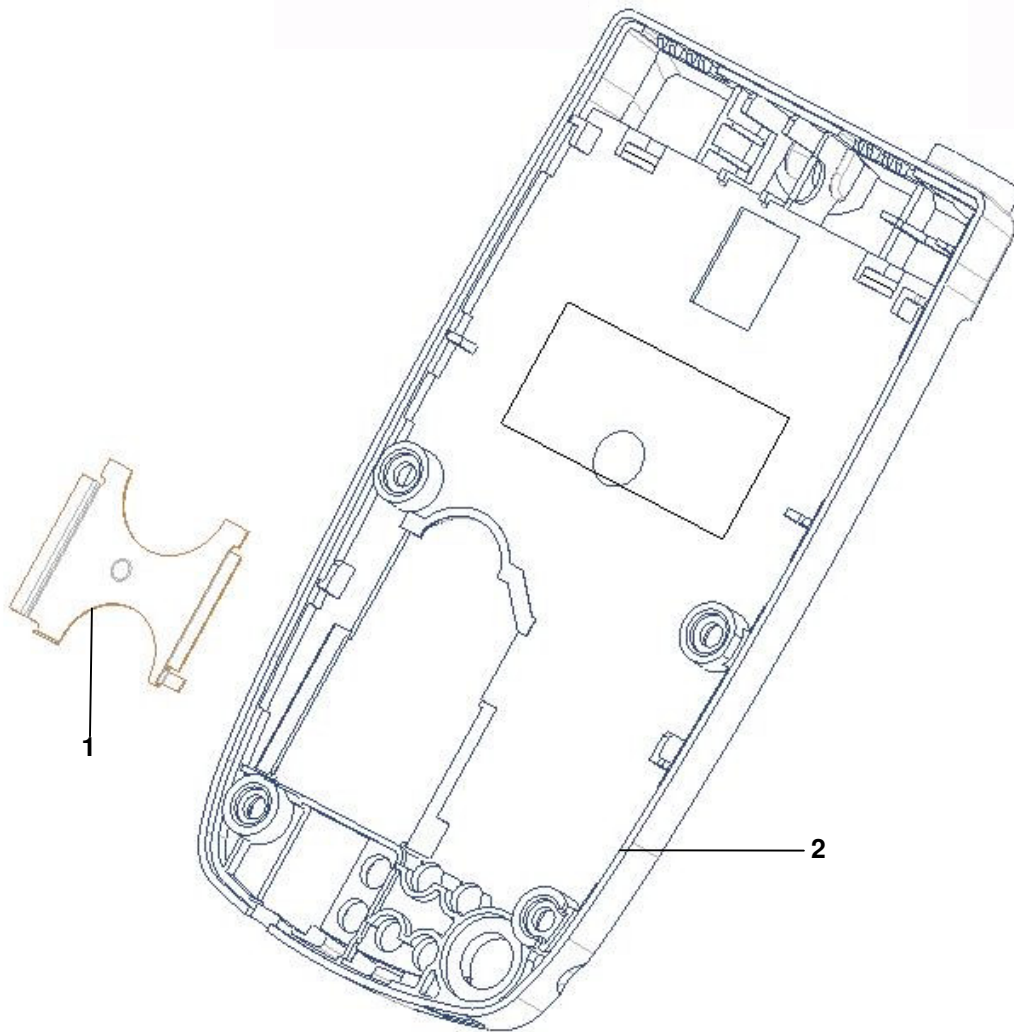
6.31 **Placement procedure :**

1. From the internal view of the back cover, place the SIM cover (1) in position in its housing.
2. Click fit the SIM cover (1) on the plate.

6.32 **Further operations :**

1. Replace the back cover ([Proc sheet 1 01](#)).
2. Replace the battery pack ([Proc sheet 0 01](#)).
3. Carry out the radio test ([Test Sheet 04](#)).

 SAGEM	REMOVING / REPLACING THE SIM LOCKER	Proc Sheet 1 04
myC-1		2/2



 SAGEM	REMOVING / REPLACING THE VIBRATING DEVICE	Proc Sheet 1 05
myC-1		1/2

6.33 Tools :

- A 0.6mm torx screwdriver
- Tweezers

6.34 Preliminary operation

1. Remove the battery ([Proc sheet 0 01](#)).
2. Remove the back cover ([Proc sheet 1 01](#)).

6.35 Removal procedure :

1. Remove, with the tweezers, the vibrating device (1) in its housing .

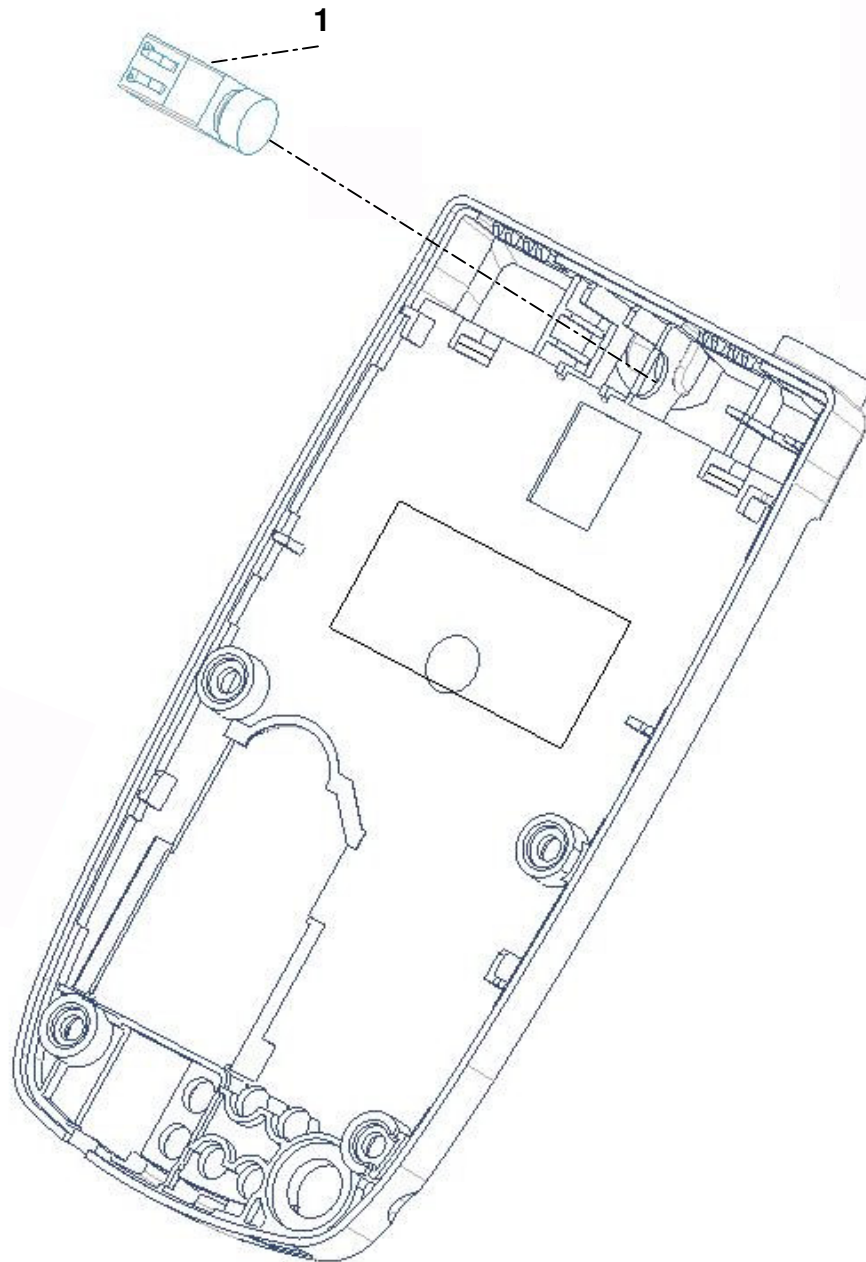
6.36 Placement procedure :

1. Put the vibrating device in its housing, respecting the foolproof device

6.37 Further operations :

1. Replace the back cover ([Proc sheet 1 01](#)).
2. Replace the battery pack ([Proc sheet 0 01](#)).
3. Carry out the radio test ([Test Sheet 04](#)).

 SAGEM	REMOVING / REPLACING THE VIBRATING DEVICE	Proc Sheet 1 05
myC-1		1/2



LEVEL 2 MAINTENANCE

 SAGEM	REMOVING / REPLACING THE MICROPHONE	Proc Sheet 2 01
myC-1		1/2

6.38 **Tools :**

- A 0.6mm torx screwdriver
- Soldering iron

6.39 **Preliminary operation**

1. Remove the battery pack ([Proc sheet 0 01](#)).
2. Remove the back cover ([Proc sheet 1 01](#)).

6.40 **Removal procedure :**

1. Unstick the ground tape (2) of the electronic board (1)
2. Turn the electronic board (1) round to liberate it from the front cover
3. Unsolder the microphone (2) on the electronic board (1)
4. Remove the microphone (1)

6.41 **Placement procedure :**

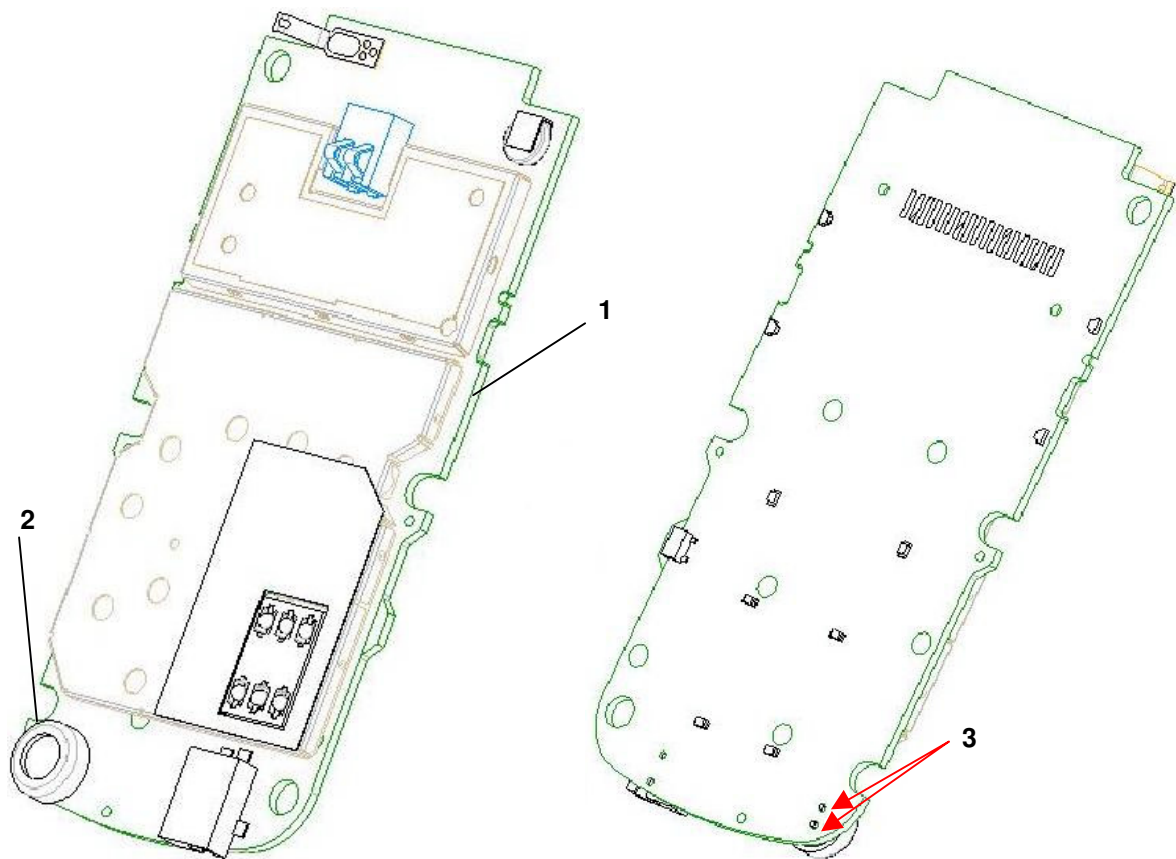
1. Replace the microphone (2) in its housing
2. Flux the place of the microphone contact (3) and solder it on the electronic board (1)
3. Position the electronic board (1) in its housing
4. Stick the ground tape (2) on the electronic board (1) by fixing correctly on the radio shielding

Nota: If the ground tape have been damaged during operations, change automatically the LCD foam for ESD.

6.42 **Further operations :**

1. Remove the back cover ([Proc sheet 1 01](#)).
2. Remove the battery pack ([Proc sheet 0 01](#)).

 SAGEM	REMOVING / REPLACING THE MICROPHONE	Proc sheet 2 01
myC-1		2/2



 SAGEM	REMOVING / REPLACING THE CHARGER CONNECTOR	Proc Sheet 2 02
myC-1		1/2

6.43 **Tools :**

- A 0.6mm torx screwdriver
- Soldering iron

6.44 **Preliminary operation**

1. Remove the battery pack ([Proc sheet 0 01](#)).
2. Remove the back cover ([Proc sheet 1 01](#)).

6.45 **Removal procedure :**

1. Unstick the ground tape (2) of the electronic board (1)
2. Turn the electronic board (1) round to liberate it from the front cover
3. Unsolder the charger connector (2) on the electronic board (1)
4. Remove the charger connector (1)

6.46 **Placement procedure :**

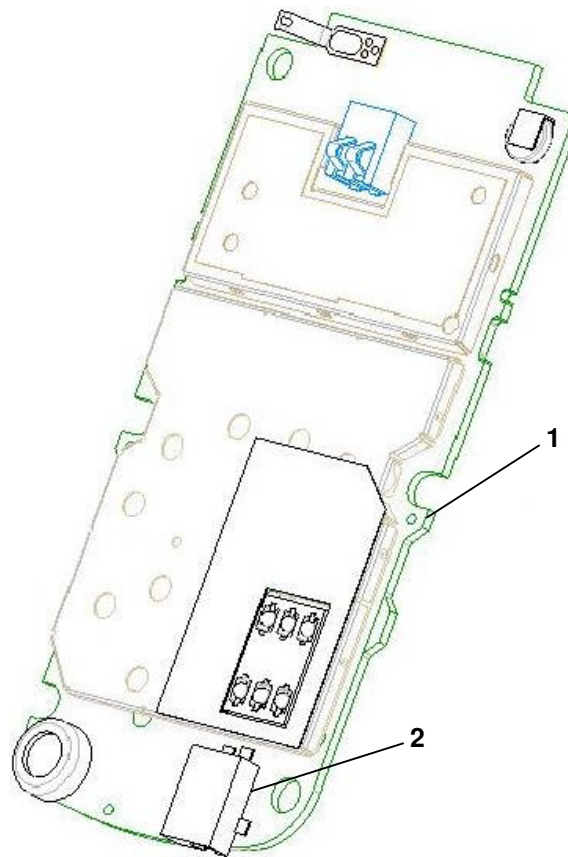
1. Replace the charger connector (2) in its housing
2. Flux the place of the charger connector contact and solder it on the electronic board (1)
3. Position the electronic board in its housing
4. Stick the ground tape (2) on the electronic board (1) by fixing correctly on the radio shielding

Nota: If the ground tape have been damaged during operations, change automatically the LCD foam for ESD.

6.47 **Further operations :**

1. Remove the back cover ([Proc sheet 1 01](#)).
2. Remove the battery pack ([Proc sheet 0 01](#)).

 SAGEM	REMOVING / REPLACING THE CHARGER CONNECTOR	Proc sheet 2 02
myC-1		2/2



 SAGEM	REMOVING / REPLACING EQUIPPED FLIP	Proc Sheet 2 03
myC-1		1/2

6.48 **Tools :**

- Tweezers
- A 0.6mm torx screwdriver
- Soldering iron
- Flat screwdriver

6.49 **Preliminary operation**

1. Remove the battery pack ([Proc sheet 0 01](#)).
2. Remove the back cover ([Proc sheet 1 01](#)).

6.50 **Removal procedure :**

1. Unstick the ground tape (2) of the electronic board (1)
2. Unsolder the loudspeaker wires (3) and the flip ground wire (4) on the electronic board (1), by noting the wiring sense (loudspeaker and flip ground wires colours can change according to supplying)
3. Remove the electronic board (1)
4. Press the hinge (6) inside the front cover by means of (curved) tweezers to release the equipped flip (5)
5. Remove the equipped flip (5)

6.51 **Placement procedure :**

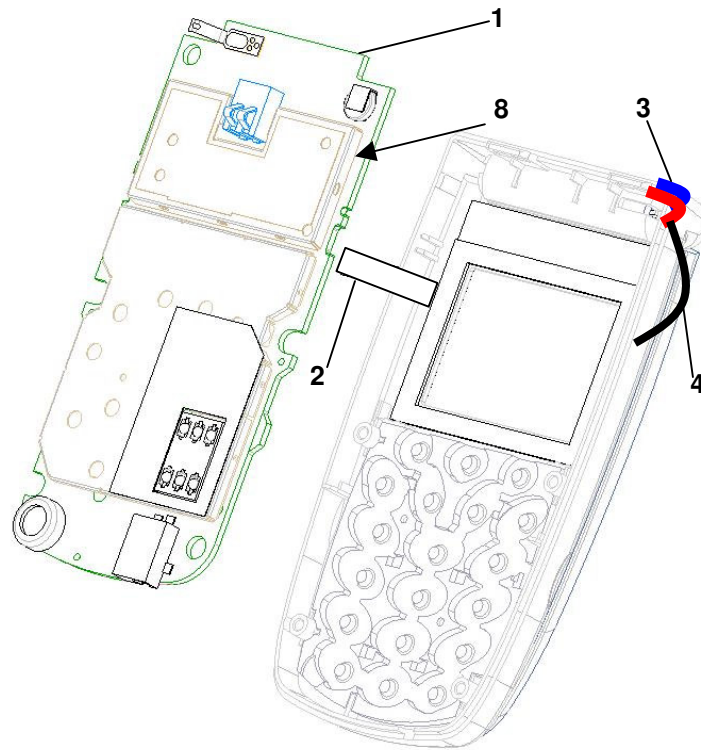
1. Position the equipped flip (5) in its housing by inserting the loudspeaker wires (3) and the flip ground wire (4) into the front cover
2. Press firmly the hinge (6) with a flat screwdriver, to fix the equipped flip (5) on the front cover
3. Replace the electronic board in its housing (3)
4. Flux the place of the loudspeaker wires (3) and solder it on the electronic board (1), respecting the wiring sense
5. Solder the flip ground wire (4) on the side of the radio shielding (8)
6. Stick the ground tape (2) on the electronic board (1) by fixing correctly on the radio shielding

Nota: If the ground tape have been damaged during operations, change automatically the LCD foam for ESD.

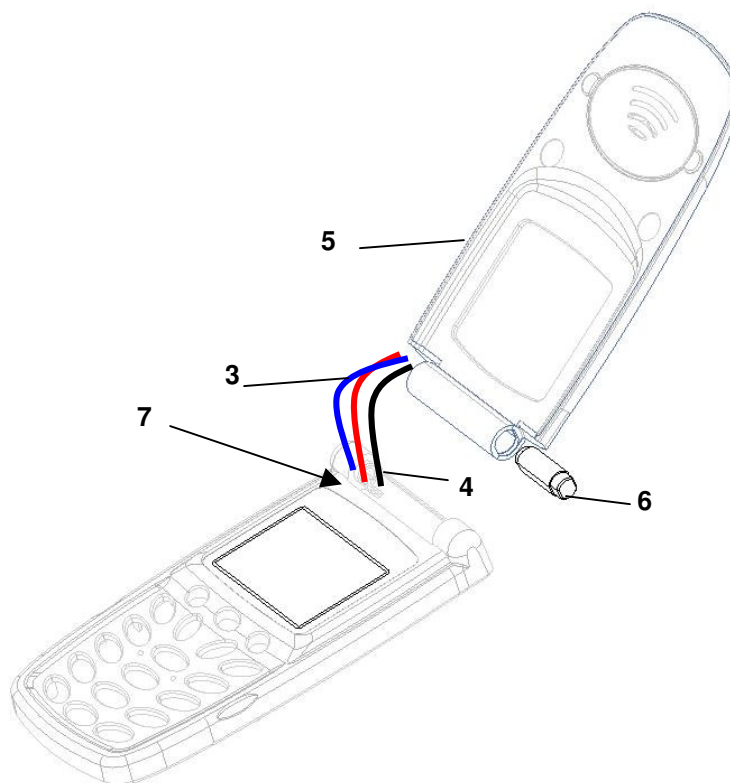
6.52 **Further operations :**

1. Remove the back cover ([Proc sheet 1 01](#)).
2. Remove the battery pack ([Proc sheet 0 01](#)).

 SAGEM	REMOVING / REPLACING THE EQUIPPED FLIP	Proc sheet 2 03
myC-1		2/2



 SAGEM	REMOVING / REPLACING THE EQUIPPED FLIP	Proc sheet 2 03
myC-1		2/2



 SAGEM	REMOVING / REPLACING THE FRONT COVER	Proc Sheet 2 04
myC-1		1/2

6.53 **Tools :**

- Tweezers
- A 0.6mm torx screwdriver
- Soldering iron

6.54 **Preliminary operation**

1. Remove the battery pack ([Proc sheet 0 01](#)).
2. Remove the back cover ([Proc sheet 1 01](#)).

6.55 **Removal procedure :**

1. Unstick the ground tape (2) of the electronic board (1)
2. Unsolder the loudspeaker wires (3) and the flip ground wire (4) on the electronic board (1), by noting the wiring sense (loudspeaker and flip ground wires colours can change according to supplying)
3. Remove the electronic board (1)
4. Press the hinge (6) inside the front cover by means of (curved) tweezers to release the equipped flip (5)
5. Remove the front cover (9)

6.56 **Placement procedure :**

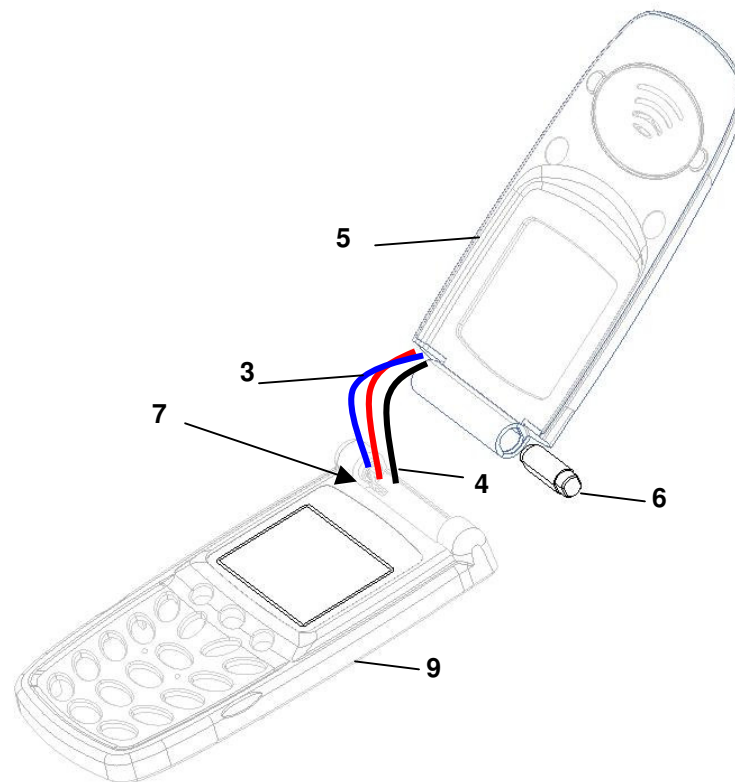
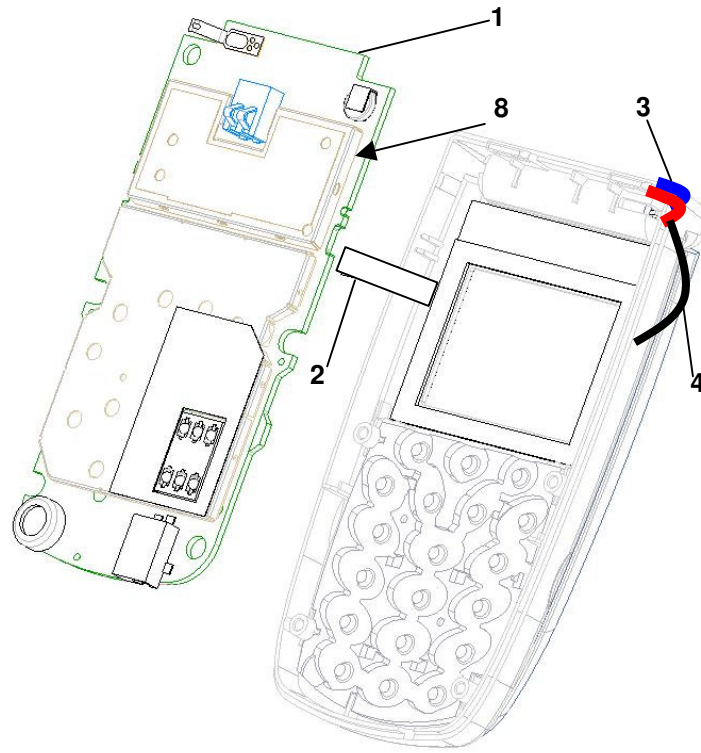
1. Position the equipped flip (5) in its housing by inserting the loudspeaker wires (3) and the flip ground wire (4) into the front cover
2. Press firmly the hinge (6) with a flat screwdriver, to fix the equipped flip (5) on the front cover
3. Replace the electronic board in its housing (3)
4. Flux the place of the loudspeaker wires (3) and solder it on the electronic board (1), respecting the wiring sense
5. Solder the flip ground wire (4) on the side of the radio shielding (8)
6. Stick the ground tape (2) on the electronic board (1) by fixing correctly on the radio shielding

Nota: If the ground tape have been damaged during operations, change automatically the LCD foam for ESD.

6.57 **Further operations :**

1. Remove the back cover ([Proc sheet 1 01](#)).
2. Remove the battery pack ([Proc sheet 0 01](#)).

 SAGEM	REMOVING / REPLACING THE FRONT COVER	Proc Sheet 2 04
myC-1		2/2



 SAGEM	REMOVING / REPLACING THE FRONT COVER	Proc Sheet 2 04
myC-1		2/2

 SAGEM	REMOVING / REPLACING THE LOUDSPEAKER	Proc Sheet 2 05
myC-1		1/2

6.58 **Tools :**

- Tweezers
- A 0.6mm torx screwdriver
- Soldering iron
- Flat screwdriver

6.59 **Preliminary operation**

1. Remove the battery pack ([Proc sheet 0 01](#)).
2. Remove the back cover ([Proc sheet 1 01](#)).

6.60 **Removal procedure :**

1. Unstick the ground tape (2) of the electronic board (1)
2. Unsolder the loudspeaker wires (3) and the flip ground wire (4) on the electronic board (1), by noting the wiring sense (loudspeaker and flip ground wires colours can change according to supplying)
3. Remove the electronic board (1)
4. Press the hinge (6) inside the front cover by means of (curved) tweezers to release the equipped flip (5)
5. Remove the equipped flip (5)

6.61 **Placement procedure :**

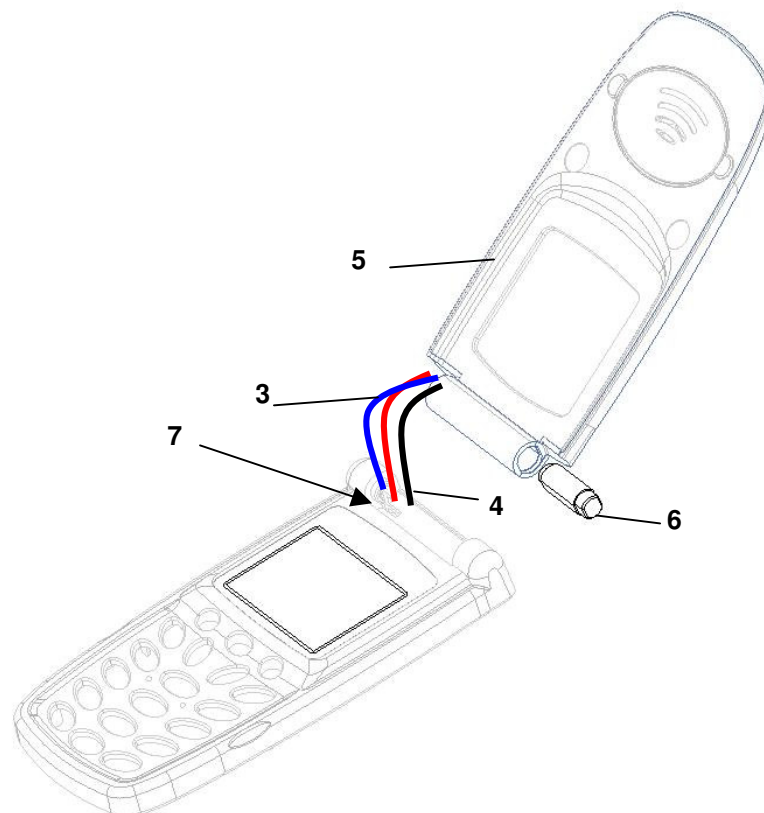
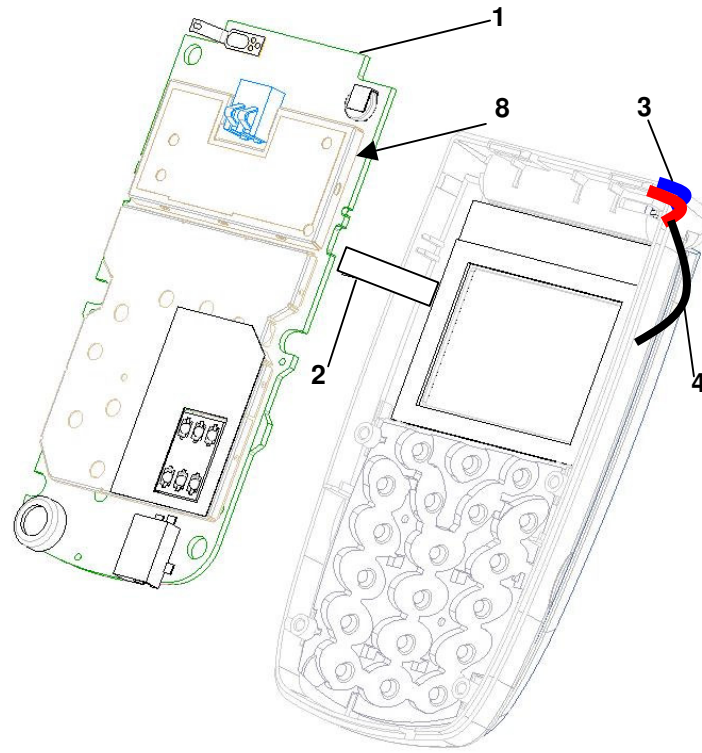
1. Position the equipped flip (5) in its housing by inserting the loudspeaker wires (3) and the flip ground wire (4) into the front cover
2. Press firmly the hinge (6) with a flat screwdriver, to fix the equipped flip (5) on the front cover
3. Replace the electronic board in its housing (3)
4. Flux the place of the loudspeaker wires (3) and solder it on the electronic board (1), respecting the wiring sense
5. Solder the flip ground wire (4) on the side of the radio shielding (8)
6. Stick the ground tape (2) on the electronic board (1) by fixing correctly on the radio shielding

Nota: If the ground tape have been damaged during operations, change automatically the LCD foam for ESD.

6.62 **Further operations :**

1. Remove the back cover ([Proc sheet 1 01](#)).
2. Remove the battery pack ([Proc sheet 0 01](#)).

 SAGEM	REMOVING / REPLACING THE LOUDSPEAKER	Proc sheet 2 05
myC-1		2/2



 SAGEM	REMOVING / REPLACING THE LOUDSPEAKER	Proc sheet 2 05
myC-1		2/2

 SAGEM	REMOVING / REPLACING THE DISPLAY	Proc Sheet 2 06
myC-1		1/1

Nota: This operation needs particulars tools. The electronic board shall return to SAGEM centre.

 SAGEM	REMOVING / REPLACING THE ELECTRONIC BOARD	Proc Sheet 2 07
myC-1		1/2

6.63 Tools :

- Soldering iron
- A 0.6mm torx screwdriver

6.64 Preliminary operation

1. Remove the battery pack ([Proc sheet 0 01](#)).
2. Remove the back cover ([Proc sheet 1 01](#)).

6.65 Removal procedure :

1. Unstick the ground tape (2) of the electronic board (1)
2. Unsolder the loudspeaker wires (4) and the flip ground wire (5) on the electronic board (1), by noting the wiring sense (loudspeaker and flip ground wires colours can change according to supplying)
3. Remove the electronic board (1)

6.66 Placement procedure :

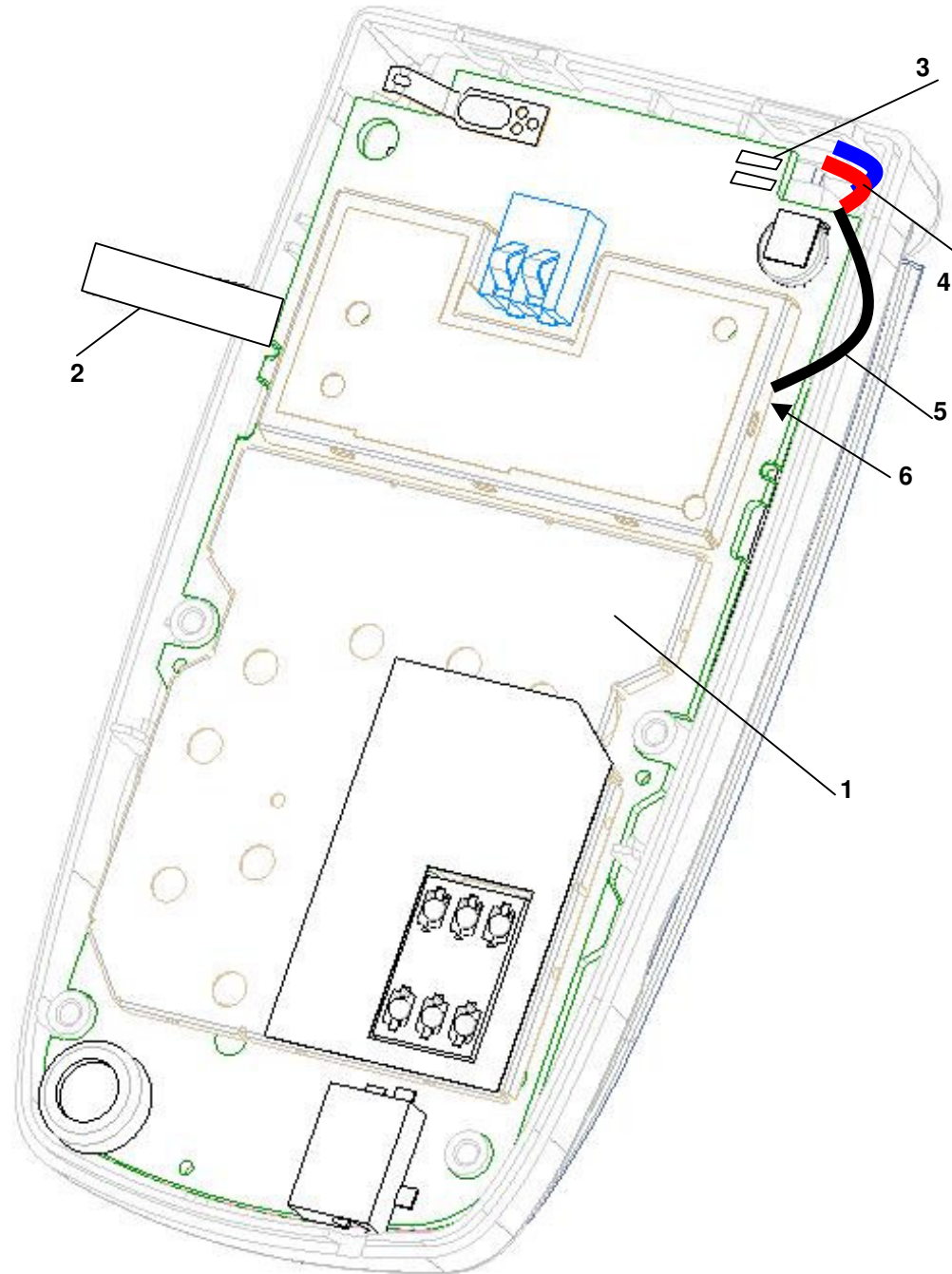
1. Replace the elastomer (5) keypad into the new front cover (3)
2. Replace the electronic board in its housing (3)
3. Flux the place of the loudspeaker wires (4) and solder it on the electronic board (1), respecting the wiring sense
4. Solder the flip ground wire (5) on the side of the radio shielding (6)
5. Stick the ground tape (2) on the electronic board (1) by fixing correctly on the radio shielding


Nota: If the ground tape have been damaged during operations, change automatically the LCD foam for ESD.

6.67 Further operations :

1. Remove the back cover ([Proc sheet 1 01](#)).
2. Remove the battery pack ([Proc sheet 0 01](#)).
1. Carry out the radio test ([Test Sheet 06](#)).

 SAGEM	REMOVING / REPLACING THE ELECTRONIC BOARD	Proc Sheet 2 07
myC-1		2/2



 SAGEM	ELECTRONIC BOARD EXCHANGE	Proc Sheet 2 08
myC-1		1/3

6.68 Preliminary operation

1. Control of the IMEI label integrity
2. Remove the electronic board (Proc sheet 2 06)
3. Control of any oxidation marks (on the electronic board and under the metal dome)

6.69 Return procedure :

- (a) The electronic boards are packaged in individual electrostatic envelopes. They must be stocked in their original package of reception , to insure a good protection against external attacks (see enclosed photos)
- (b) During the electronic boards manipulation , gloves and electrostatic strap must be worn at all times.
- (c) The defective electronic boards have to be returned to SAGEM factory, packaged individually, in the original package (see enclosed photos) , in the appropriate ESD box : One box per Sagem reference (check reference written on the box).
- (d) The defective board should display the defect code written on a sticker (placed on the shielding) and written on the ESD bag label too (printed with SMT).

Note :

On the defective boards , it is necessary to check visually under the metal dome to discover if it shows oxidation marks. The defective boards should be returned with their original metal dome

Boards with oxidation should not to set in conformance with the warranty


The defective boards must never be mixed with the complete mobiles

6.70 Placement procedure :

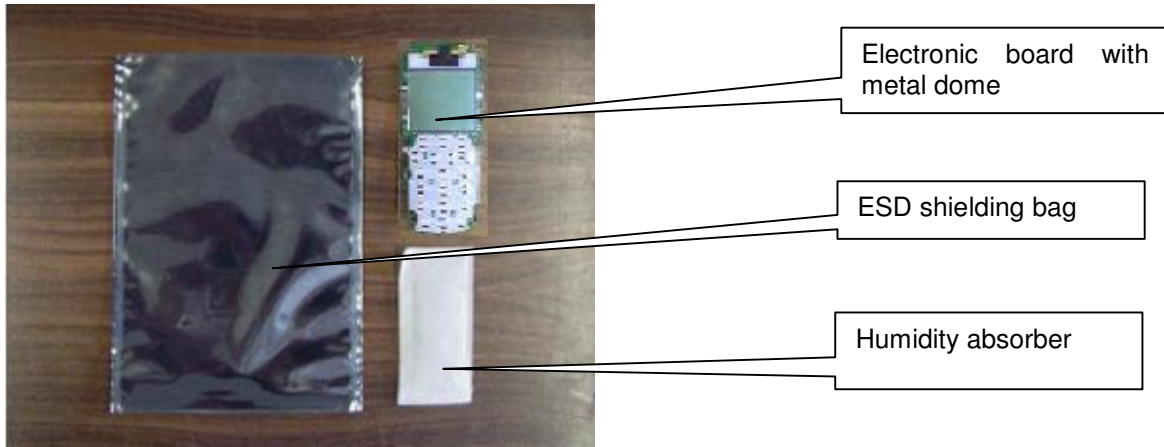
1. Take a board in the stock of swap boards from the same Sagem reference.

6.71 Further operations :

1. Place the new electronic board.([Proc sheet 2 06](#))
2. Follow stages (see enclosed photos)

 SAGEM	ELECTRONIC BOARD EXCHANGE	Proc sheet 2 08
myC-1		2/3

Example of electronic boards packaging :



Boards packaging SAGEM -> ARC

Boards packaging ARC -> SAGEM




ESD shielding bag closed by the product label




Write the defect code on

ESD shielding bag closed by the IMEI label

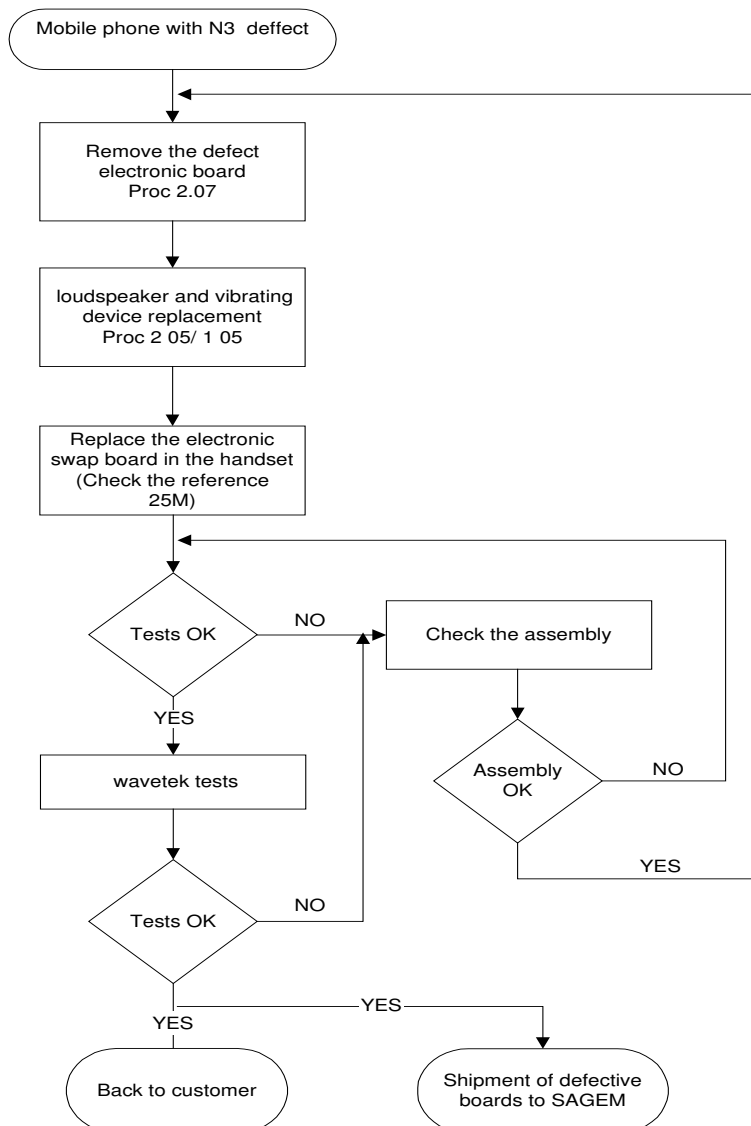
 SAGEM	ELECTRONIC BOARD EXCHANGE	Proc sheet 2 08
myC-1		2/3



SAGEM electrostatic shielding box
Reference 20 boards: 27441180-4
Reference 100 boards: 27 511110-6

 SAGEM	ELECTRONIC BOARD EXCHANGE	Proc sheet 2 08
myC-1		3/3

Electronic board exchange process



Detection of N3 defect : See the Technical documentation

-Check oxidation under the metal dome .

- Audio parameters written on the new swap board

- Display test : Hot Line Menu
- Keypad test
- Vibrating device test

- See Technical documentation (test sheet 04)

- Follow return instructions page 5-35

IMPORTANT

Mobile packaging sent to SAGEM S.A. :

Follow the Proc sheet 2 07

Packaging for swap or mobile components storage :

The swap and the mobile components must be stored with a particular care especially for the most sensible component (Display , loudspeaker etc...).

LEVEL 3 MAINTENANCE

Informations CRA/CRA information :		Garantie/Warranty :	
Nom/Name :		Garantie standard/Standard warranty :	
Rue /Street :		Déjà réparé/préviously repaired :	
Ville / City :		Hors garantie/Out of warranty :	
Code postal /Poscode :		Garantie expirée /Expired warranty :	
Pays/Country :		Mauvaise utilisation / Misuse :	
Telephone /Phone :			
Nom du produit/product :		N° Série/Sérial n° :	
Date d'achat/Date of purchase :		N° IMEI :	
Code SAGEM	Type de défauts	Type of fault	
PROBLEME D'AFFICHAGE			
A1	PAS D AFFICHAGE LED ETEINTES	DISPLAY PROBLEM	
A2	PAS D AFFICHAGE LED ALLUMÉES	NO POWER UP	
A3	BLOCAGE DE L AFFICHAGE	NO WAKE UP	
A5	AFFICHEUR CASSE	FREEZES UP	
A6	LIGNE, DIGIT OU PIXEL MANQUANT, CONTRASTE, COULEUR	BROKEN LCD	
A7	PB RETROECLAIRAGE	MISSING LINE, DIGIT or PIXEL, CONTRAST, COLOR	
PROBLEME D'ANTENNE			
A10	ANTENNE CASSEE / ABSENTE	ANTENNA PROBLEM	
PROBLEME D'ALIMENTATION / CHARGEUR			
B1	CONTACT BATTERIE DU MOBILE DEFECTUEUX	BROKEN / MISSING ANTENNA	
B2	CONNECTEUR DE CHARGE DU MOBILE DEFECTUEUX	POWER SUPPLY / CHARGING PROBLEM	
B3	ALIMENTATION CARTE DEFECTUEUSE	DEFECTIVE MOBILE BATTERY CONTACT	
B4	AFFICHAGE CHARGE DEFECTUEUX	DEFECTIVE MOBILE CHARGER CONNECTOR	
B5	CONSOMMATION MODE ETEINT	DEFECTIVE POWER SUPPLY OF THE BOARD	
B7	PROBLEME D AUTONOMIE	DEFECTIVE CHARGE ICON DISPLAY	
B8	BATTERIE DEFECTUEUSE	CURRENT CONSUMPTION WITH PHONE OFF	
B9	TENUE MECANIQUE BATTERIE	AUTONOMY	
B10	BATTERIE CASSEE	ELECTRICALLY DEFECTIVE BATTERY	
B11	CHARGEUR DEFECTUEUX	MECHANICAL LOCK PROBLEM ON BATTERY	
B12	CHARGEUR CASSE	BROKEN BATTERY	
B13	COUPURE INTERMITTENTE AVEC REDEMARRAGE	DEFECTIVE CHARGER	
B14	COUPURE INTERMITTENTE SANS REDEMARRAGE	BROKEN CHARGER	
PROBLEME DE CLAVIER			
C1	CLAVIER INOPERANT	KEYBOARD PROBLEM	
C2	PROBLEME TOUCHE LATERALE	NOT FUNCTIONING KEYBOARD	
MESSAGE D'ERREUR			
D1	SIM ABSENTE	LATERAL TOUCH PROBLEM	
D2	AUTRES MESSAGES	ERROR MESSAGE	
D3	PB EEPROM	SIM MISSING	
D4	MOBILE NON REGLE	OTHER MESSAGES	
D5	HARD FAILURE	EEPROM	
D6	SIM VERROU	UNTUNED MOBILE	
D7	CODE POSTE	HARD FAILURE	
D8	RETOUR SAV	SIM VERROU	
D9	BATTERIE INCONNUE	POST CODE BLOCKED	
PROBLEME AUDIO			
E1	HP DEFECTUEUX (grésille)	SAV RETURN	
E2	HP VOIX DEFORMEE OU PARASITES	UNKNOWN BATTERY	
E3	MICRO DEFECTUEUX	AUDIO PROBLEM	
E4	MICRO VOIX DEFORMEE OU PARASITE (DISTANT)	DEFECTIVE LOUDSPEAKER (halls)	
E5	PROBLEME DE VIBREUR	LOUDSPEAKER VOICE DISTORTION	
E6	CONNECTEUR AUDIO DEFECTUEUX	DEFECTIVE MICROPHONE	
PROBLEME DE COMMUNICATION			
F1	PAS DE LOCALISATION RESEAU	MICRO VOICE DISTORTION	
F2	COUPURE DE COMMUNICATION	VIBRATING DEVICE PROBLEM	
F4	TEST RADIO NON OK	DEFECTIVE AUDIO CONNECTOR	
F5	ECHEC APPEL SORTANT	COMMUNICATION PROBLEM	
F6	ECHEC APPEL ENTRANT	NO NETWORK RETRIEVAL	
F7	PERTE TEMPORAIRE DE RESEAU	INTERMITTENT CALLS DROP	
PROBLEME COSMETIQUE / DEFAUT VISUEL			
G1	VITRE CASSEE OU ABIMEE	TEST RADIO NO OK	
G2	COQUE CASSEE OU ABIMEE	OUTGOING CALL FAILURE	
G3	FLAP CASSE OU ABIME	INCOMING CALL FAILURE	
G5	CLAVIER CASSE OU ABIME	NETWORK TEMPORARY DROP	
G6	BOUTON VERROU DEFECTUEUX	COSMETIC PROBLEM	
AUTRES PROBLEMES			
H1	KIT ACCESSOIRES HS	BROKEN OR DAMAGED GLASS	
H2	FONCTION FM (MOBILE)	BROKEN OR DAMAGED COVER	
H3	FONCTION MONETIQUE	BROKEN OR DAMAGED FLIP	
I1	TRACE D OXYDATION	BROKEN OR DAMAGED KEYBOARD	
I3	PAS DE DEFAUT CONSTATE	DEFECTIVE LOCK BUTTON	
I5	MANQUE FONCTION DANS MENU	OTHER PROBLEM	
I6	CONNECTEUR SIM DEFECTUEUX	BROKEN OR DAMAGED ACCESSORY	
I7	DYSFONCTIONNEMENT D'UNE FONCTION DU MENU	FM FUNCTION (Mobile)	
I8	RECONFIGURATION DU MOBILE	MONETIC FUNCTION	
I9	LISTE NOIRE	OXYDATION MARKS	
PROBLEME MULTIMEDIA			
K1	PROBLEME DATA (SMS, EMS, SMS,GPRS, WAP, TELECHARGEMENT JEUX, SONNERIES, SAUVEUR D'ECRAN, NE COMMUNIQUE PAS AVEC UN PC, POCKET PC OU PALM)	NO FAULT FOUND	
K2	FONCTION VIDEO	LACK FUNCTION IN THE MENU	
K3	FONCTION INFRAROUGE (IRDA)	DEFECTIVE SIM CONNECTOR	
Garantie/Warranty :			
Garantie standard/Standard warranty :			
Déjà réparé/préviously repaired :			
Hors garantie/Out of warranty :			
Garantie expirée /Expired warranty :			
Mauvaise utilisation / Misuse :			

Cachet du Vendeur/Dealer's Stamp :		Informations Client /Information :	
		Nom/Name :	
		Rue /Street :	
		Ville / City :	
		Code postal /Postcode :	
		Pays/Country :	
		Telephone /Phone :	
Nom du produit/product :		N° Série/Sérial n° :	
Date d'achat/Date of purchase		N° IMEI :	
Garantie/Warranty :		Hors garantie/Out of warranty :	
Garantie standard/Standard warranty :		Garantie expirée /Expired warranty :	
Déjà réparé/préviously repaired :		Mauvaise utilisation / Missuse	
Code SAGEM	Type de défaut	Kind of fault	
A0	AFFICHAGE DEFECTUEUX	DISPLAY MALFUNCTION	
A10	ANTENNE CASSEE / ABSENTE	ANTENNA BROKEN / MISSING	
B0	ALIMENTATION/CHARGE	POWER SUPPLY / NO CHARGE	
B7	PROBLEME D'AUTONOMIE	AUTONOMY	
B8	BATTERIE DEFECTUEUSE	BROKENBATTERY	
B11	CHARGEUR DEFECTUEUX	CHARGER MALFUNCTION	
C0	PROBLEME CLAVIER	KEYBOARD MALFUNCTION	
C2	PROBLEME TOUCHE LATERALE	LATERAL TOUCH PROBLEM	
D0	MESSAGE D'ERREUR	ERROR MESSAGE	
D1	SIM ABSENTE	SIM MISSING	
D7	CODE POSTE	POST CODE BLOCKED	
E0	PROBLEME AUDIO	AUDIO PROBLEM	
E3	MICRO DEFECTUEUX	MICROPHONE MALFUNCTION	
E5	PROBLEME DE VIBREUR	VIBRATING DEVICE MALFUNCTION	
F0	PROBLEME DE COMMUNICATION	COMMUNICATION MALFUNCTION	
G1	VITRE CASSEE OU ABIMEE	BROCKEN GLASS	
G2	COQUE CASSEE OU ABIMEE	BROCKEN COVER	
G3	FLAP CASSE OU ABIME	BROKEN FLIP	
G5	CLAVIER CASSE OU ABIME	BROCKEN KEYBOARD	
G6	BOUTON VERROU DEFECTUEUX	DEFECTIVE LOCK BUTTON	
K2	FONCTION VIDEO	VIDEO FUNCTION	
K3	FONCTION INFRAROUGE (IRDA)	INFRARED FUNCTION (IRDA)	
K4	FONCTION WAP	WAP FUNCTION	
K5	FONCTION GPRS	GPRS FUNCTION	
K6	FONCTION SMS, EMS, MMS.	SMS, EMS, MMS FUNCTION	
K7	NE COMMUNIQUE PAS AVEC UN PC	NO COMMUNICATION WITH A PC	
K8	NE COMMUNIQUE PAS AVEC UN POCKET PC OU PALM	NO COMMUNICATION WITH A POCKET PC or PALM	
K9	LIAISON DATA (MESSAGE "AUCUNE PORTEUSE DETECTEE")	DATA (MESSAGE "NO CARRIER DETECTED")	
K10	TELECHARGEMENT JEUX	DOWNLOADING GAME	
K11	TELECHARGEMENT IMAGE / SON / ECONOMISEUR D'ECRAN	DOWNLOADING PICTURE / RINGTONE / SCREEN SAVE	
H1	KIT ACCESSOIRES HS	BROCKEN ACCESSORIES	
H2	FONCTION FM (MOBILE)	FM FUNCTION	
H3	FONCTION MONETIQUE	MONETIC FUNCTION	
I5	MANQUE FONCTION DANS MENU	LACK FUNCTION IN THE MENU	
I7	DYSFONCTIONNEMENT D'UNE FONCTION DU MENU	MALFUNCTION OF THE MENU	
I8	RECONFIGURATION DU MOBILE	MOBILE RETROFIT	
I9	BLACK LISTE	BLACK LIST	
I0	AUTRES DEFAUTS A PRESICER	OTHERS / TO BE PRECISED	

CHAPTER 7 - TECHNICAL INFORMATION BULLETIN

7.1 PURPOSE

The purpose of the Technical Information Bulletin (TIB) is to complete the maintenance operations described in this document. They give to the repair centers the complementary technical informations and the corrective procedures to be applied to maintain the product following it's evolution.

7.2 APPLICATION











The Technical Information Bulletin (TIB) are reference and must be applied by the repair centers.



The Technical Information Bulletin (TIB) will be sent only to the concerned repair centers. The Technical Data Bulletin will not be received by the repair centers with a reference number in sequence.

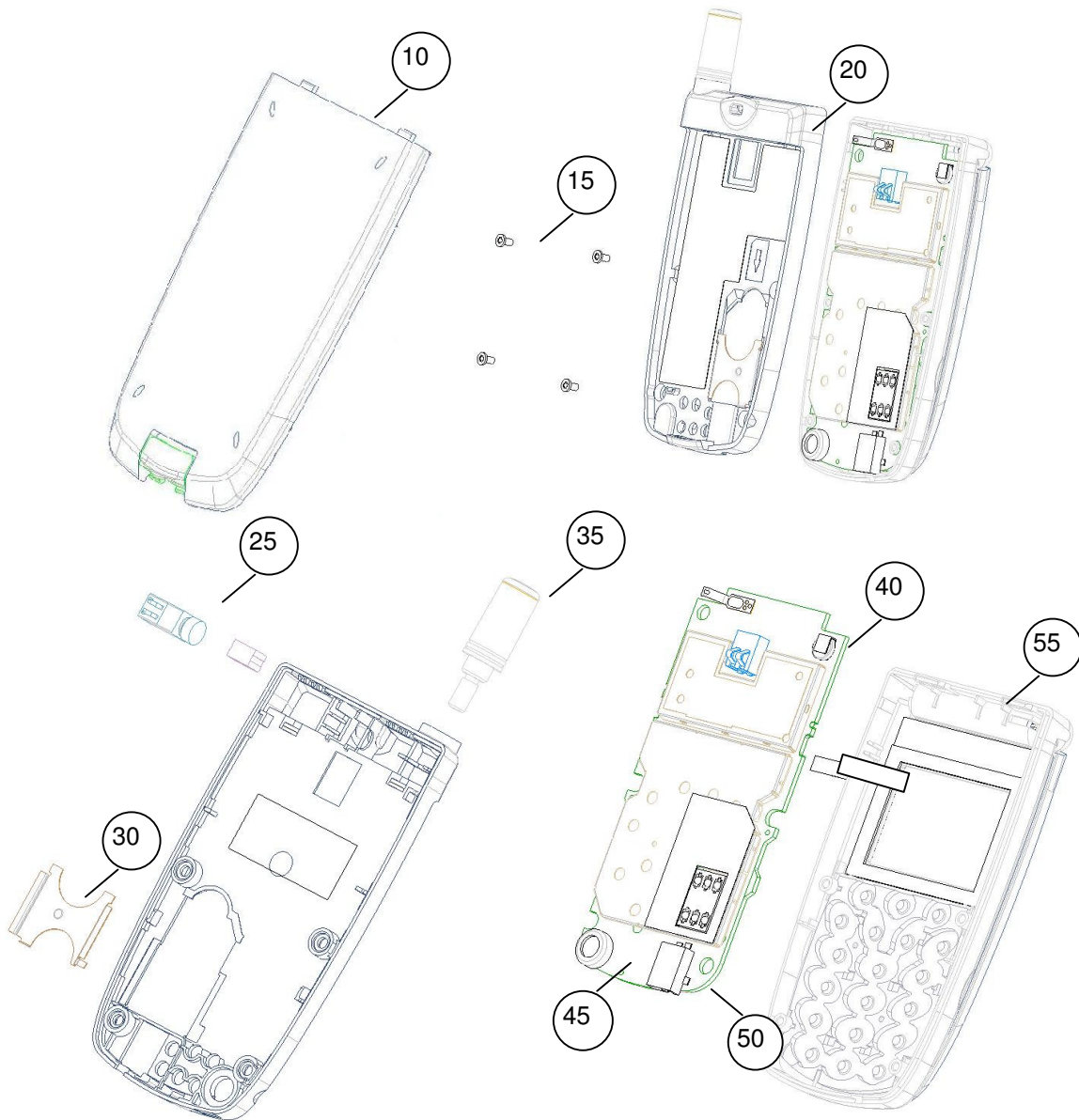
The follow up of the Technical Information Bulletin (TIB) and the action being to be performed are under the responsibility of the repair centers.

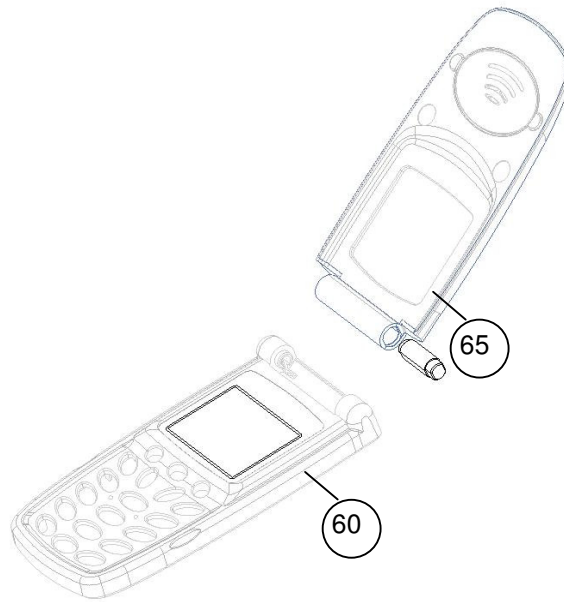
CHAPTER 8 - ILLUSTRATED PART CATALOG

7.1 myC-1 spare parts

ASSEMBLY	QTY	DESIGNATION	PHOTOS
10	1	Pack battery	
15	4	RLX 1,8-6 screw	
20	1	Back cover	
25	1	Vibrating device	
30	1	SIM locker	
35	1	Antenna	
40	6	Electronic board	
45	1	Microphone	
50	1	Charger connector	
55	1	LCD foam for ESD	

60	1	Front cover	
65	1	Equipped flip	





CHAPTER 9 - COMPOSITION TABLE

9.1 *PURPOSE*

This chapter contains the SAGEM codes of articles mentioned throughout the Site Technical Documentation.

9.2 *LIST OF ARTICLES*

TEST TOOLS	
Designation	Reference
myC-1 LCD/Metal dome jig	25 155 605-3
Calibration tool	25 152 979-1